# Malaysian Pacific Industries Berhad

MALAYSIAN PACIFIC INDUSTRIES BERHAD

INVESTOR PRESENTATION

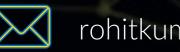
Q 4 F Y 2 O 2 3 (Apr - Jun '23)



Rohit Kumar









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# Business overview

### MPI – A MEMBER OF THE HONG LEONG GROUP

# Hong Leong Group and MPI

- The Hong Leong Group was established over 50 years ago and is one of the largest conglomerates in Asia
- Carsem and Dynacraft are operating companies within Malaysian Pacific Industries, which is a part of the Manufacturing & Distribution Services segment of Hong Leong Group
- Carsem was acquired by Hong Leong over 30 years ago
- Carsem has 49 years experience in semiconductor assembly and testing
- Today, Carsem is one the most trusted and recognized names in the Outsourced Semiconductor Assembly & Test (OSAT) Industry

# Hong Leong Group Holdings

- Banking & Financial Services segment (2) is the largest segment with over
   300 banks in Asia including insurance services
- Property Development & Investment segment (3) builds and manages commercial and residential real estate around the world
- Hospitality & Leisure segment (4) is comprised of hotel and casino operators in Macau and Las Vegas
- Hong Leong continues to grow by acquisition and owns more than 50% stake in each of their group companies

# The Hong Leong Group One of the Largest Conglomerates in Malaysia Manufacturing Hospitality & & Distribution services **Property** Development & Investment **Banking &** Financial services



# Financial performance snapshot

STRONG FUNDAMENTALS CREATE BUSINESS RESILIENCE IN TOUGH TIMES

Revenue (RM million)

482

Q4 FY23

Net cash (RM million)

801

as of Q4 FY23

EBITDA (%)

21%

Q4 FY23

CAPEX (RM million)

59

Q4 FY23



# Business outlook

# Semiconductor industry growth has slowed down



- Economic headwinds (inflation and recessionary risks) persist leading to sluggish end consumer demand environment (global GDP growth to drop to 3% in 2023, as per IMF);
- Weak 2023 outlook with expectations of a 11% drop in semiconductor industry revenue vs. 2022 (Gartner);
- Elevated inventory levels and dipping chip prices are fueling the slowdown in semiconductor industry
- Trends, such as the switch to battery electric vehicles, autonomous driving, vehicle connectivity;
  - Adoption of 5G, digitalisation, artificial intelligence, and sensing devices
  - Robust growth in computing (servers), and in industrial & renewable energy segments;
    - Intelligent applications such as smart watches, etc.

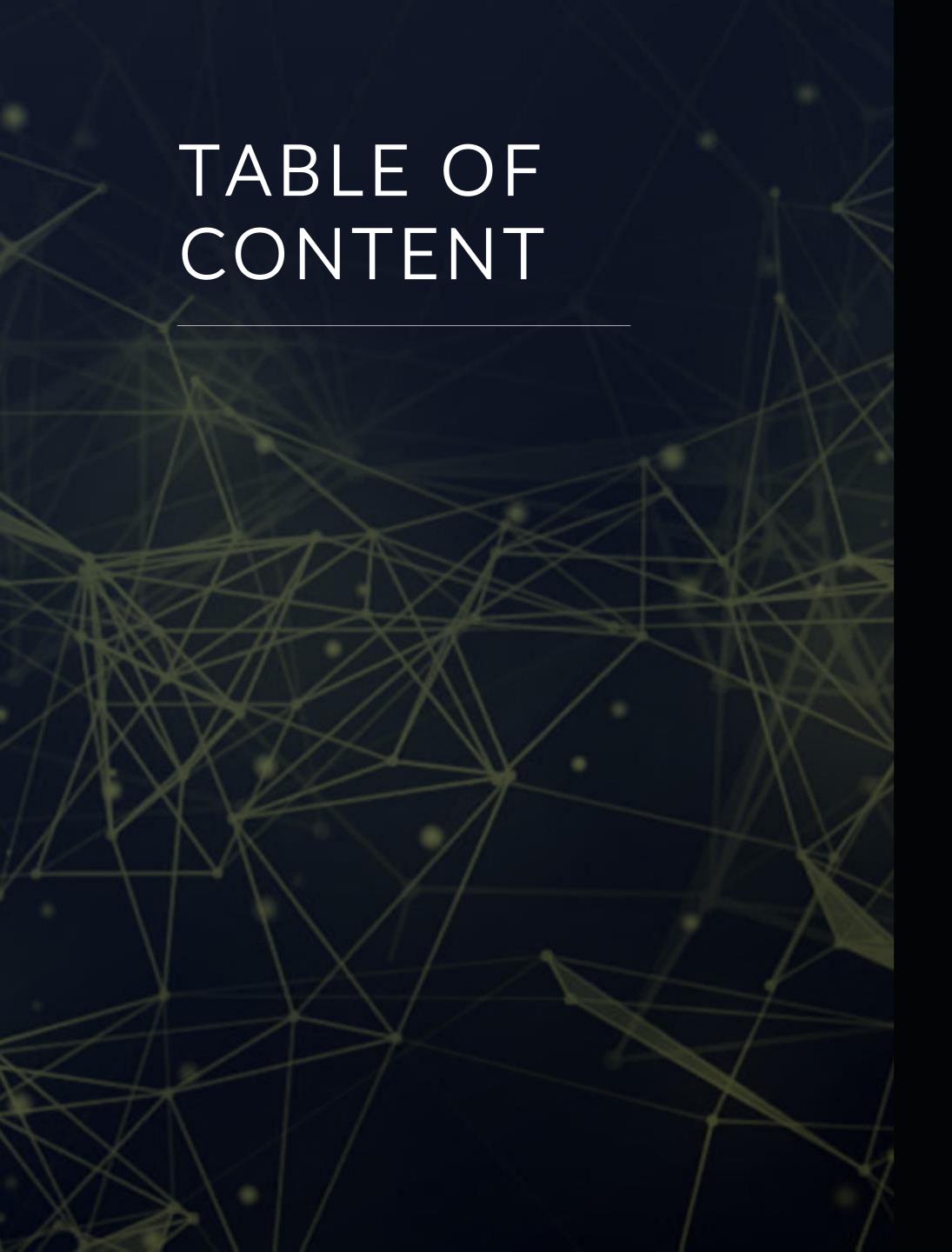


# Challenges to MPI's business



- Higher costs labour, energy, water, transportation, equipment, and raw materials from suppliers;
- Elevated inventory levels and dipping chip prices;
- End market demand drop and deferment; and
- Industrywide talent scarcity
- Prudent cost management measures such as energy consumption optimisation, freight cost reduction, etc.;
  - Close collaboration with customers to ensure a healthy overall sales pipeline short & long term;
  - Capacity expansions at China and Malaysia a reliable supply centre based out of Malaysia and China;
- Strong cash position to pursue technology/ company acquisitions to move further into advanced packaging space;
  upskilling and specialized hiring plans in place

MPI's responsive strategy

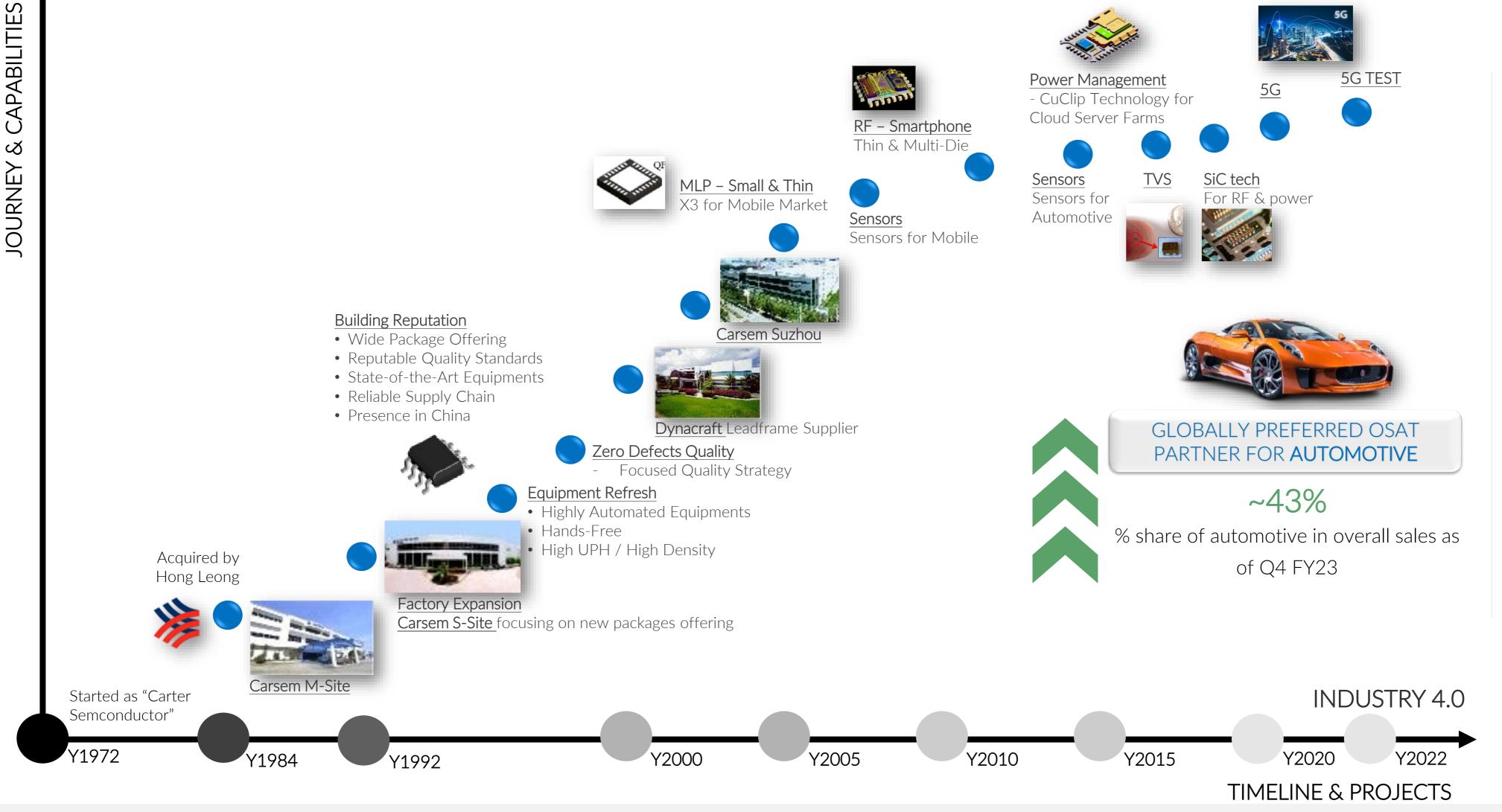


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# Our journey



### Carsem

One of the most trusted OSAT partners globally

100% Malaysian

Healthy Balance Sheet (Equity to debt 100:0)

Semiconductor Experience – 50 years



# Board of Directors

### YBHG DATUK KWEK LENG SAN

### CHAIRMAN; Non-Executive/ Non-Independent

- Appointed to BoD of MPI in Jul 1990, and as GMD of MPI from Sept 1990-Aug 1993; Member of the nominating committee
- Chairman of Hong Leong Industries Bhd., Hume Industries Bhd., and Southern Steel Bhd.; Director of Hong Leong Company (Malaysia) Bhd

### YBHG DATO' MOHAMAD KAMARUDIN BIN HASSAN

### Non-Executive Director/ Independent

- Mar 2015: Appointed to board of MPI, and is a member of the Board Audit & Risk Management Committee of MPI
- Is a Director of Duopharma Biotech Bhd and Muhibbah Engineering (M) Bhd, and ManagePay Systems Bhd

### MANUEL ZARAUZA

### GROUP MANAGING DIRECTOR/ Non-Independent

- Over 25 years of experience across various manufacturing sectors
- April 2015-Aug 2016: Joined HLMG Management as its Managing Director
- Aug 2016-Present: Group Managing Director of MPI

### DR TUNKU ALINA BINTI RAJA MUHD ALIAS

### Non-Executive Director/ Independent

- Jan 2018: Appointed to board of MPI, and is a member of Nominating Committee of MPI
- Is a Director of IJM Corporation Bhd, Batu Kawan Bhd, MBSB Bank Bhd and Raja Alias Foundation
- 1992: Set-up legal firm (Wong Lu Peen & Tunku Alina); Managing Partner till 2011, Consultant now

### IR. DENNIS ONG LEE KHIAN

### Non-Executive Director/ Independent

- Nov 2014: Appointed to board of MPI; is the Chairman of the Nominating Committee and a member of the Board Audit & Risk Management Committee of MPI
- Held directorships in Shell Malaysia Trading Sdn Bhd, Champ Distributors Sdn Bhd, Lubetech Sdn Bhd, Assar Chemical Dua Sdn Bhd and was the Chairman of the Board for UMW Pennzoil Distributors Sdn Bhd.

### MS FOO AI LI

### Non-Executive Director/ Independent

- Appointed as an Independent Non-Executive Director of the Company on 1 September 2021.
- She is presently attached to CDC Consulting Sdn Bhd providing advisory work.
- Her last position in the energy industry was as the Chief Financial Officer of Hengyuan Refining Company Berhad (formerly Shell Refining Company (FOM) Berhad) from 2016 to 2019.



# Management team

### MANY YEARS OF CONSOLIDATED EXPERIENCE IN THE INDUSTRY







### MANUEL ZARAUZA, GROUP MANAGING DIRECTOR, MPI

Over 25 years of manufacturing sector experience; Previously with Siemens, Osram Opto Semiconductors, and Seoul Semiconductor



ERIC CHEAH CFO, MPI

Extensive experience across large-scale semiconductor manufacturing & in KPMG



INDERJEET SINGH GM, CARSEM S-SITE, MY

Started his career at Carsem & went on to hold various management positions



MURALITHARAN GM, CARSEM M-SITE, MY

Previously held senior leadership positions at NXP semiconductors



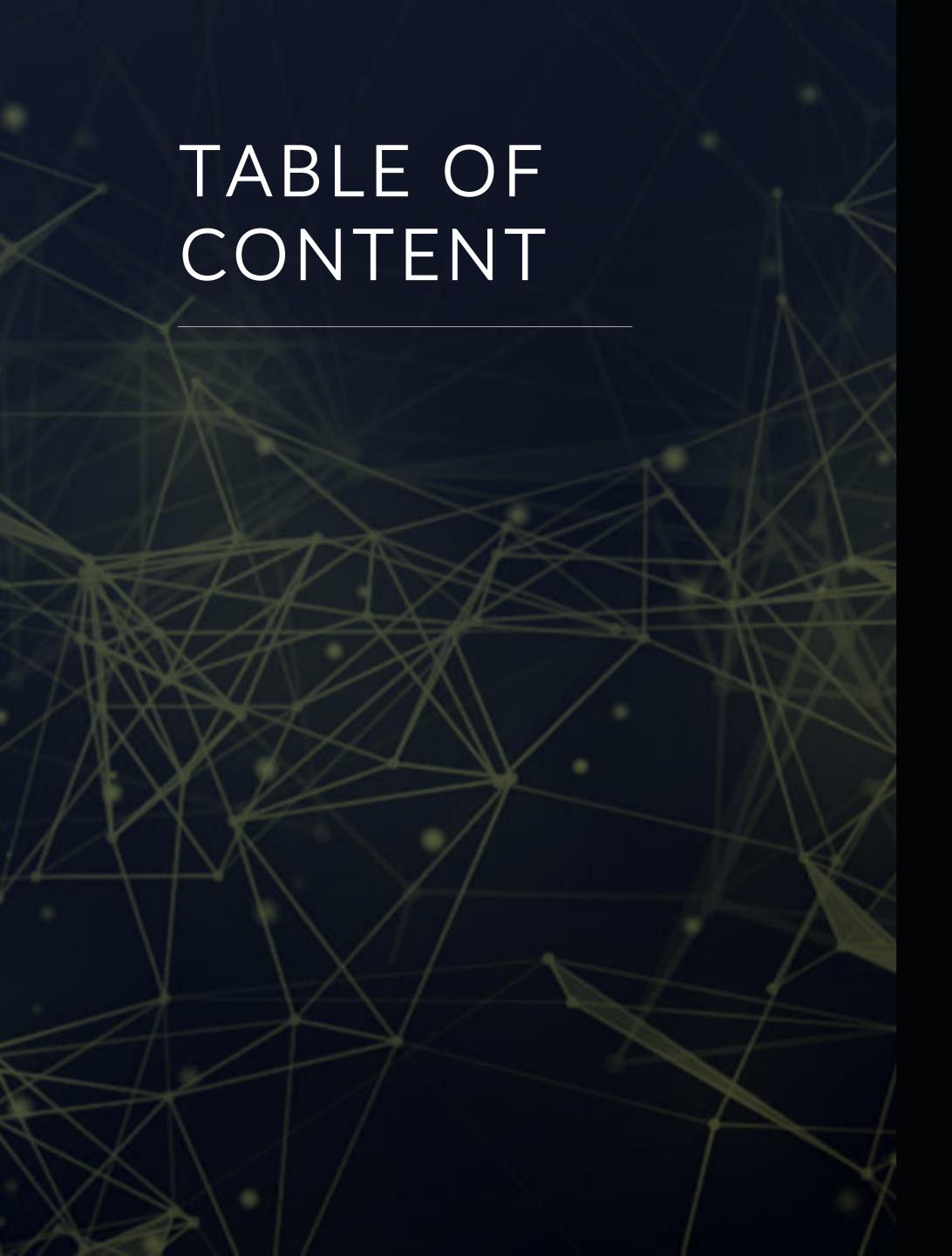
RAYMOND SHI GM, CARSEM SZ-SITE, CHINA

More than 20 years of experience with Carsem SZ handling operations



CK LEE HEAD, CARSEM CHINA

Started his career at Carsem & went on to hold various management positions



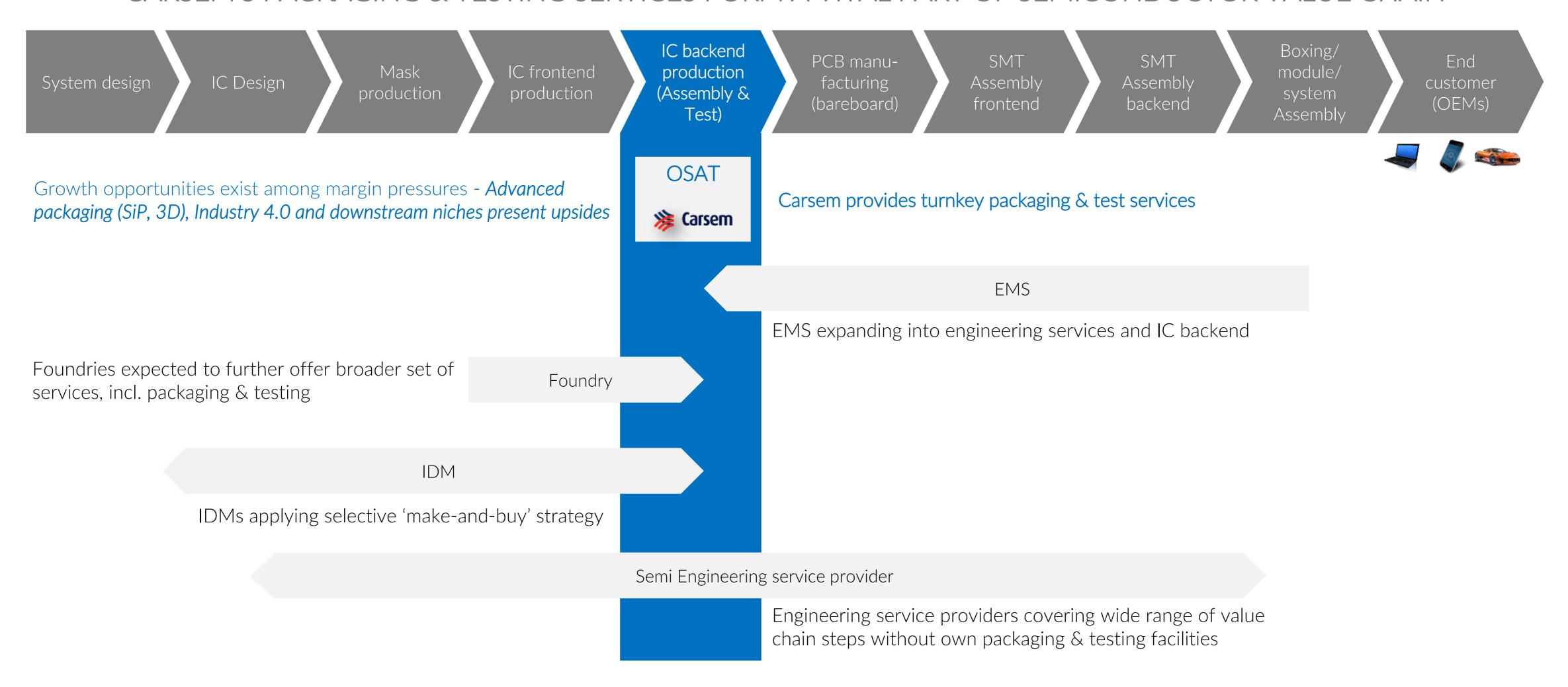
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# Supply chain & business model

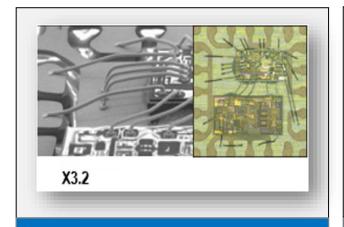
CARSEM'S PACKAGING & TESTING SERVICES FORM A VITAL PART OF SEMICONDUCTOR VALUE CHAIN



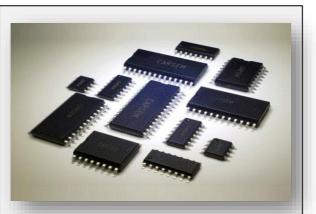


# Wide portfolio

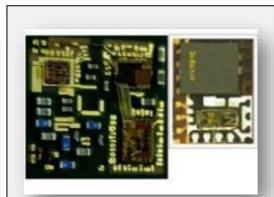
### COMPREHENSIVE TURNKEY PACKAGING & TEST SERVICES



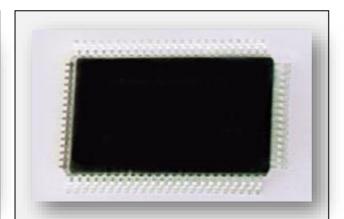
MLP



Small Outline IC



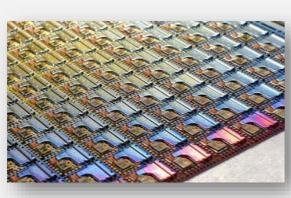
System in Package (SiP)



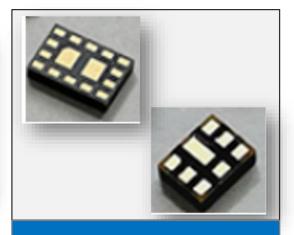
Quad Flat Package (QFP)



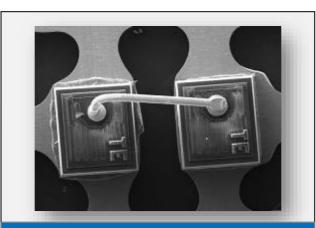
MEMS & Sensors



Copper Clip



Flip Chip



Transient Voltage Suppressor (TVS)

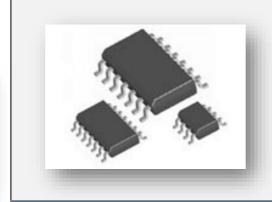


Power Management (SiC, GaN, GaN on SiC)



MICRO





IC – PDIP, SOP packages



Test

### ACROSS KEY APPLICATIONS



Automotive







PC/ Notebook





# Geographic footprint

BROAD GEOGRAPHIC PRESENCE, SERVING A GLOBAL CUSTOMER BASE





Sales offices



### CARSEM MANUFACTURING SITES & BUSINESS UNITS



### Carsem (M-Site, Ipoh)

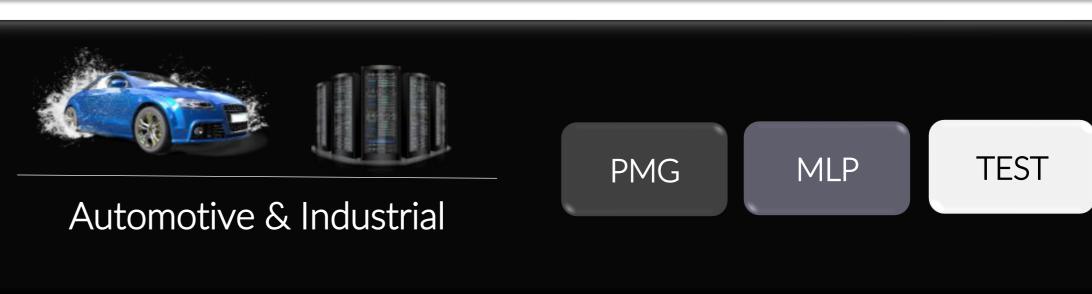
- Floor Space: 436K sq. ft. (40,500 sq. m.)
- Workforce: 2,261 employees
- GM: Muralitharan





### Carsem (S-Site, Ipoh)

- Floor Space: 640K sq. ft. (60,000 sq. m.)
- Workforce: 3,152 employees
- GM: Inderjeet Singh

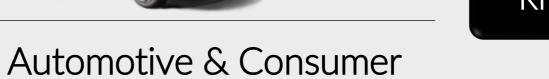




### Carsem Suzhou, China

- •Floor Space: 600K sq. ft. (56,000 sq. m.)
- •Workforce: 1,877 employees
- •GM: Raymond Shi











FC



OUR FACTORY EXPANSION PLANS CONTINUE AT M-SITE



Existing Factory = 143K sqft

New 4 storey Factory = 76K sqft

Level 4 = 15,800sqft

Future expansion

Level 3 = 20,000sqft

Future expansion

Level 2 = 20,000sqft

10K clean room production floor

Completed

Level 1 = 20,000sqft

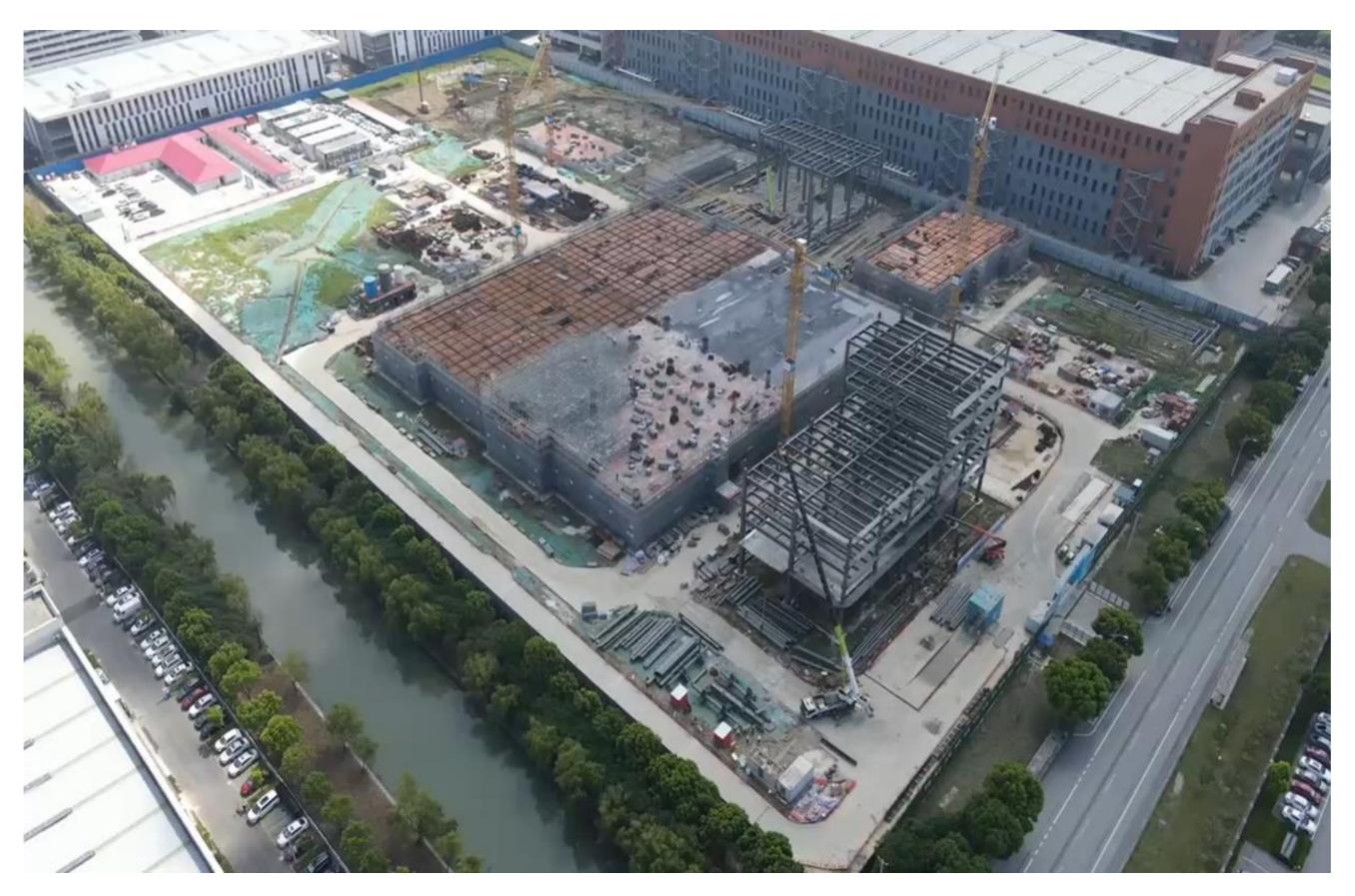
100K clean room production floor

Completed

Note: 1. Level 1 & 2 received CCC approval (Certificate of Completion and Compliance)
2. Level 3 & 4 are pending facilitisation



DESPITE NEAR TERM CHALLENGES, CONSTRUCTION OF NEW FACTORY AT SUXIANG IN CHINA CONTINUES



2023-Apr Foundation work

2023-May Foundation work

2023-Jun Scaffolding work

2023-Jul L2 formwork

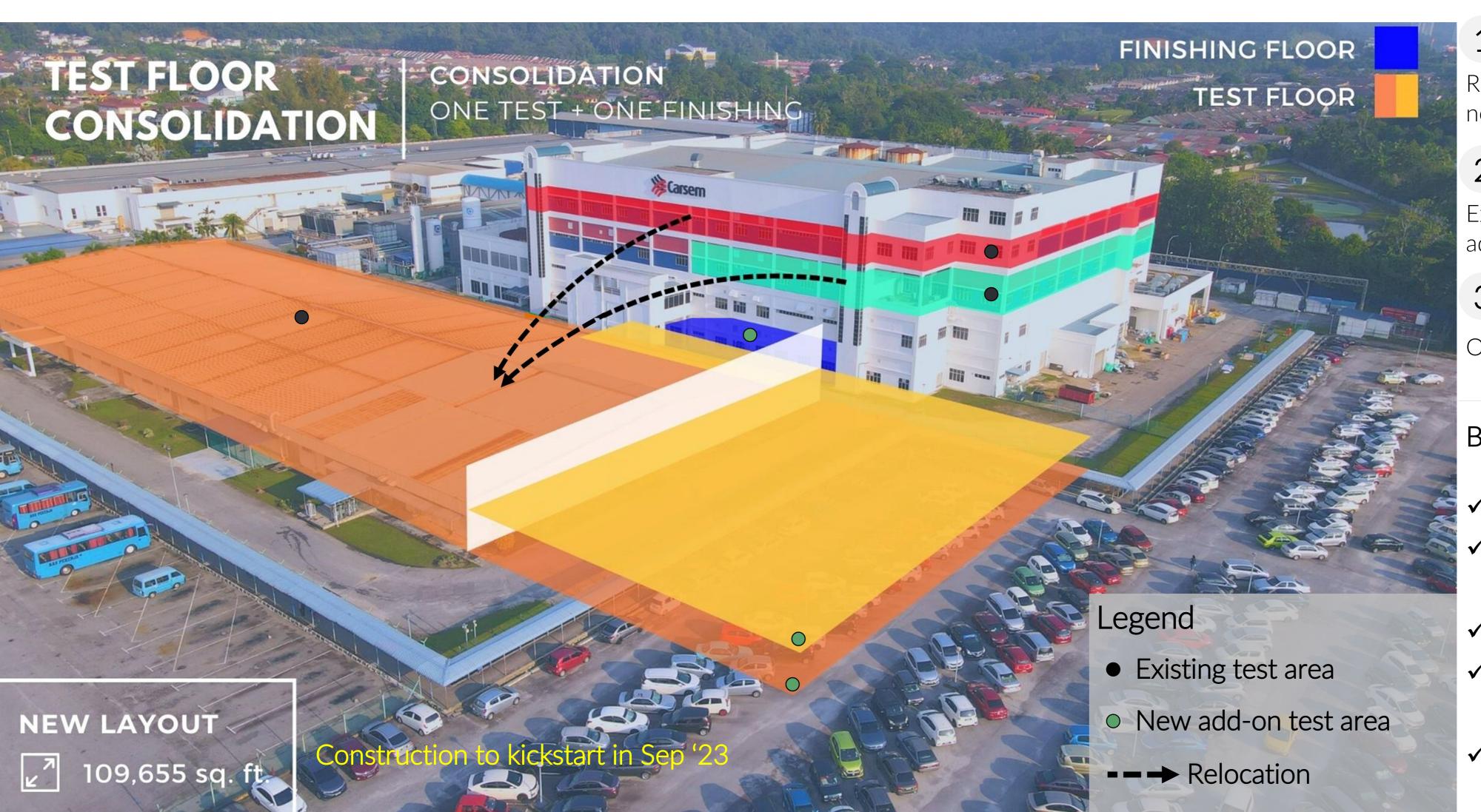
2023-Aug L2 slab casting



Production expected to commence by 2025



INVESTING AT S-SITE TO STRENGTHEN CAPABILITIES FOR THE GROWING AUTOMOTIVE & INDUSTRIAL SEGMENTS



### 1 Equipment standardization

Replacing current legacy handlers with newer high efficiency test handlers

### 2 One floor consolidation

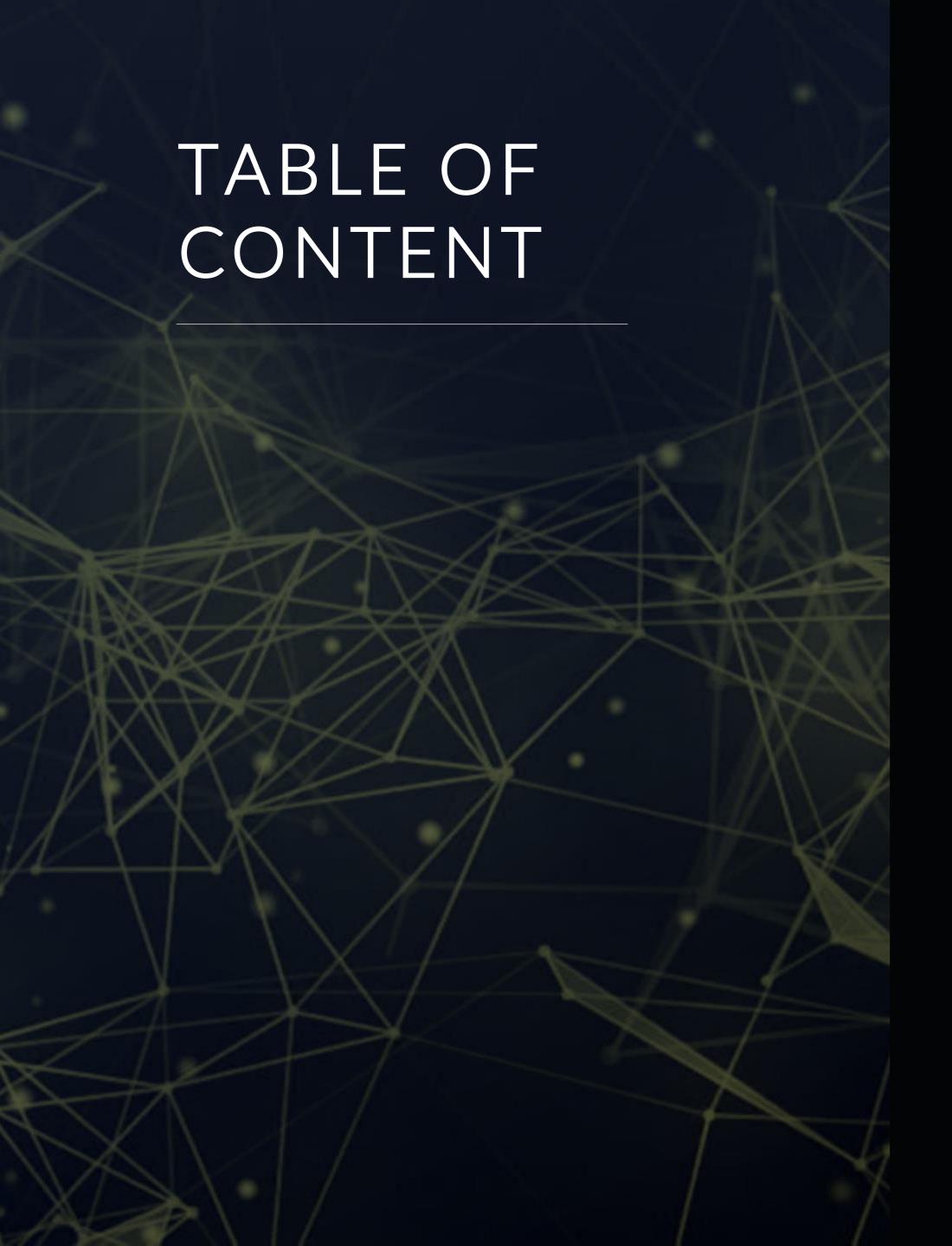
Expanding test floor to support the additional machines

### 3 Test automation

Overhead tunnel

### Benefits

- ✓ Achieve world class OEE
- ✓ Eliminate variance of test machines
- ✓ Consolidate floor space
- ✓ Automate test operations (Industry4.0, AI)
- ✓ Develop 5G capabilities

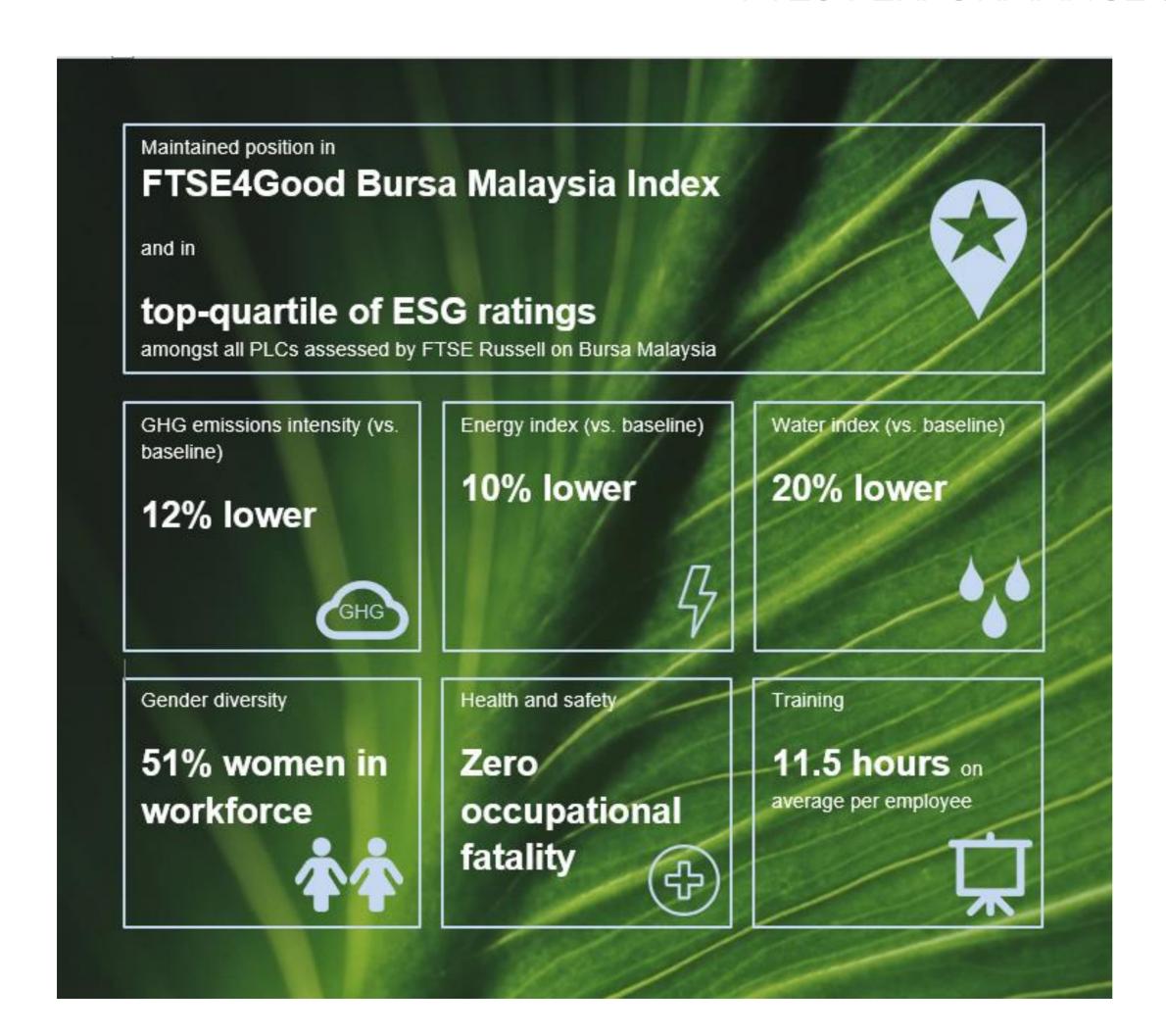


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# Sustainability performance

FY23 PERFORMANCE SNAPSHOT







# Sustainability at MPI

### OUR APPROACH IS RESPONSIBLE & RESPONSIVE, DRIVEN BY 3 THEMES









- We prioritise the safety & wellbeing of our people
- We conduct business ethically and compete fairly
- We engage with & support our communities







Employees Business ethics

Community



# UN Sustainable Development Goals

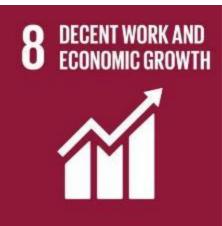
6 PRIORITY SDGs MOST ALIGNED WITH OUR BUSINESS





Safeguarding employee health & safety is a top priority for MPI

MPI makes a significant contribution towards employment and economic growth





As a global employer, MPI strives to ensure workforce diversity and address inequality

MPI actively focuses on innovation, technology and related infrastructure development





MPI's operations strive for water conservation and wastewater management

MPI has a role to play in emissions control, energy efficiency improvement and waste management





# Environment

### IMPROVING PREPAREDNESS AND RECEIVING RECOGNITION



GM gembawalk to IETS system



Initial discussion with NGO @ DOE to organise River Cleaning Program at Sungai Meru





GM gembawalk to final water discharge point









In 2022, Carsem M was specially invited to participate in the Perak State level National

Environment Day Ceremony officiated by the Menteri Besar of Perak, YAB Dato' Seri Shaarani



Carsem M has also collaborated with the Department of Environment to organise Environment Day and "Kempen Sembang Sungai Meru



# Health & safety

# EMPLOYEE AWARENESS

EMERGENCY PREPAREDNESS & RESPONSE



Safety committee meeting



Plant inspection



5S audit



Plant inspection



Machinery inspection



Accident investigation



Safety committee meeting



# Training & education

### TRAINING & UPSKILLING IS AMONG OUR TOPMOST STRATEGIC PRIORITIES

Online & offline training - ISO37001 Training, Automotive Series Training, Engineer Core Competency – DOE, 8D, Customized Course – Leadership Series



ISO37001 Standard Training



ISO37001 Standard Training



Automotive Series Training



8D & 3X5 Why Training



DOE Training



DOE Training



Team Bonding Training



Team Bonding Training



# Training, sports & recreation

Continuous education program for chemical handlers and noise hearing conservation











Carsem C.E.R.I.A & Hong Leong Sports carnival





CERTIFICATE

MALAYSIAN PACIFIC INDUSTRIES BERHAD
(INCLUDING CARSEM (M) SDN. BHD. AND DYNACRAFT
INDUSTRIES SDN. BHD.)
CARSEM (M) SDN. BHD. - M SITE
JALAN LAPANGAN TERBANG

ANTI-BRIBERY MANAGEMENT SYSTEM FOR DESIGN AND ASSEMBLY OF SEMICONDUCTOR DEVICES.

31 March 2021 : 30 March 2024

SIRIM QAS International hereby certifies that

31350 IPOH PERAK DARUL RIDZUAN MALAYSIA

IQNET



# Anti-bribery & anti-corruption

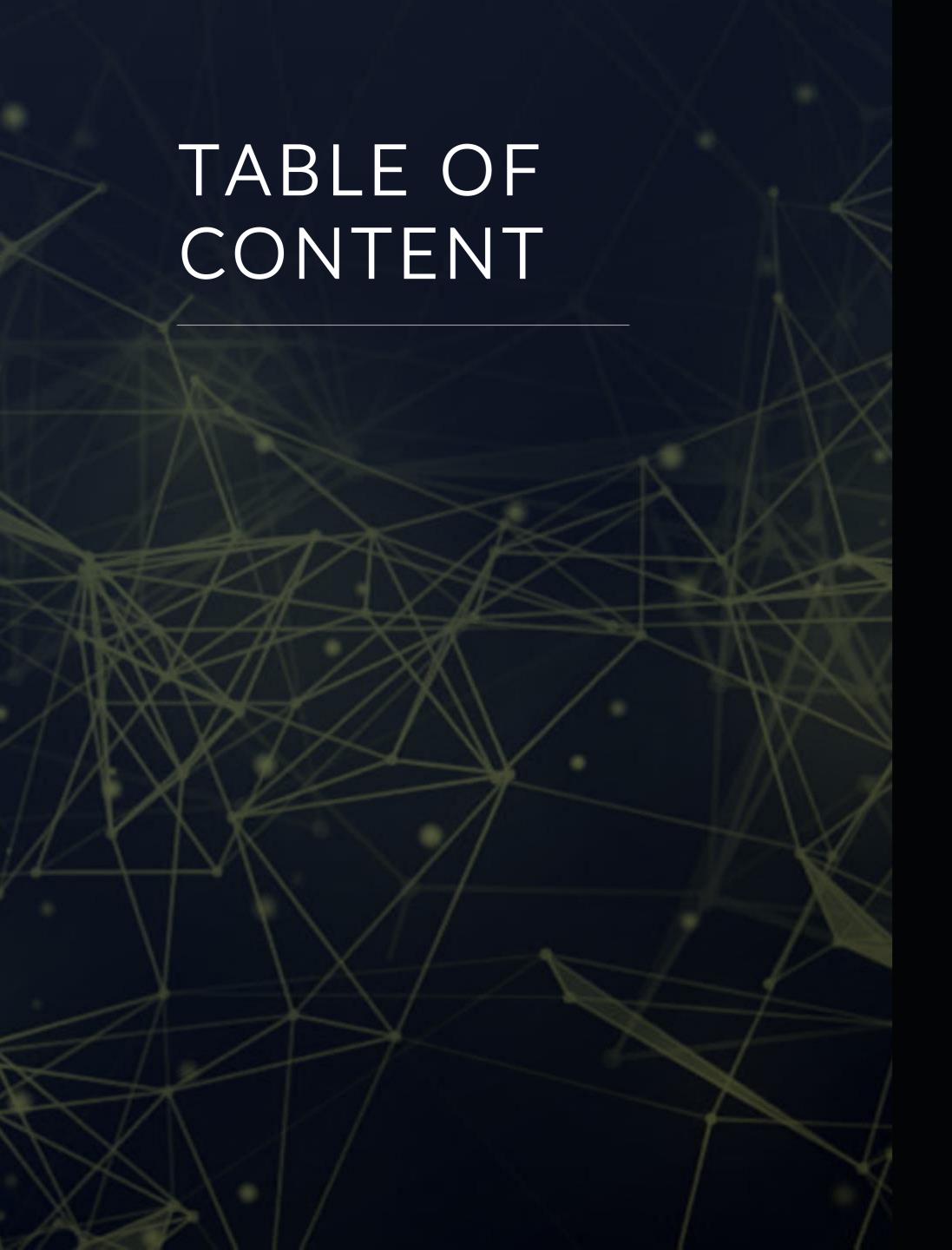
### LEADING ETHICALLY & TRANSPARENTLY

Certification for implementing Anti-Bribery Management Systems, complying with ISO 37001:2016.

Operating subsidiaries	Certifying authority	Status
Carsem M	SIRIM QAS International Sdn. Bhd.	Re-certified in FY23
Carsem SZ	Shanghai Ingeer Certification Assessment Co., Ltd.	Certified in FY23
DCI	SIRIM QAS International	Certified in FY23





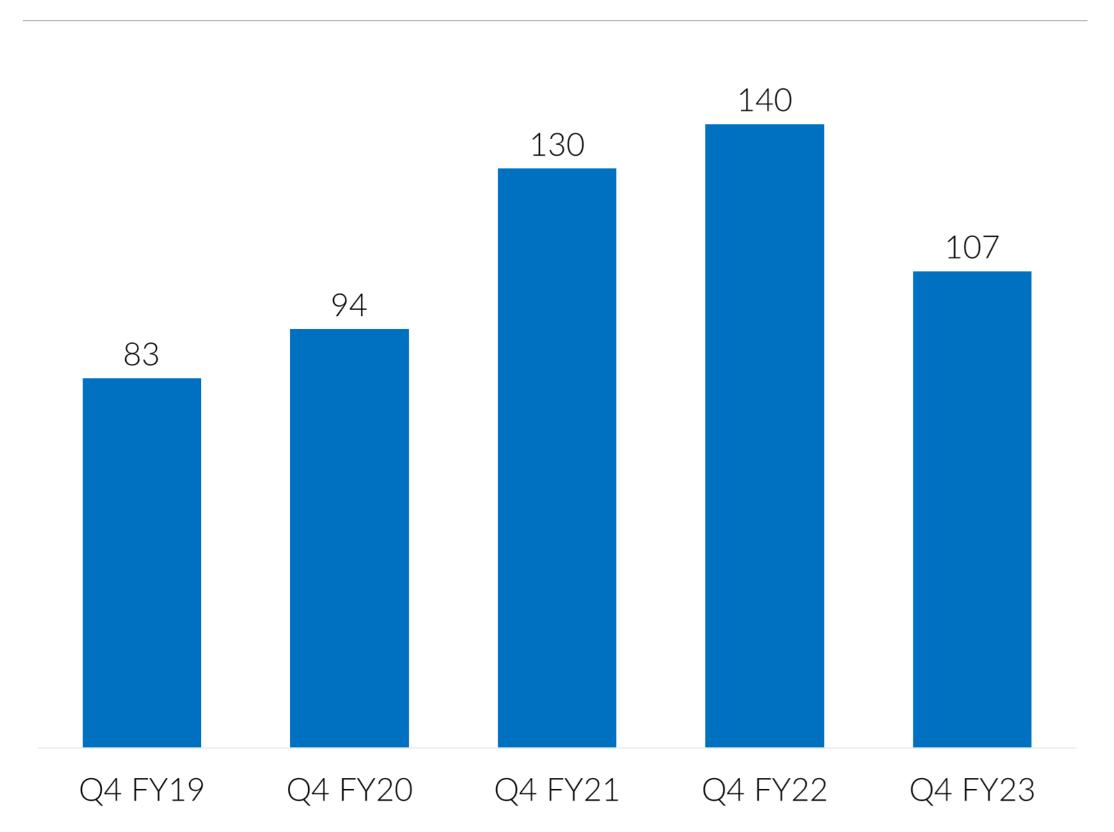


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### GLOBAL SEMICONDUCTOR INDUSTRY REVENUE IS EXPECTED TO DECLINE BY 11% IN 2023

### MPI Revenue (US\$ million)



Economic headwinds persist leading to weak end consumer demand environment







✓ Smartphone shipment fell further by 10% annually - 6th consecutive quarter of decline

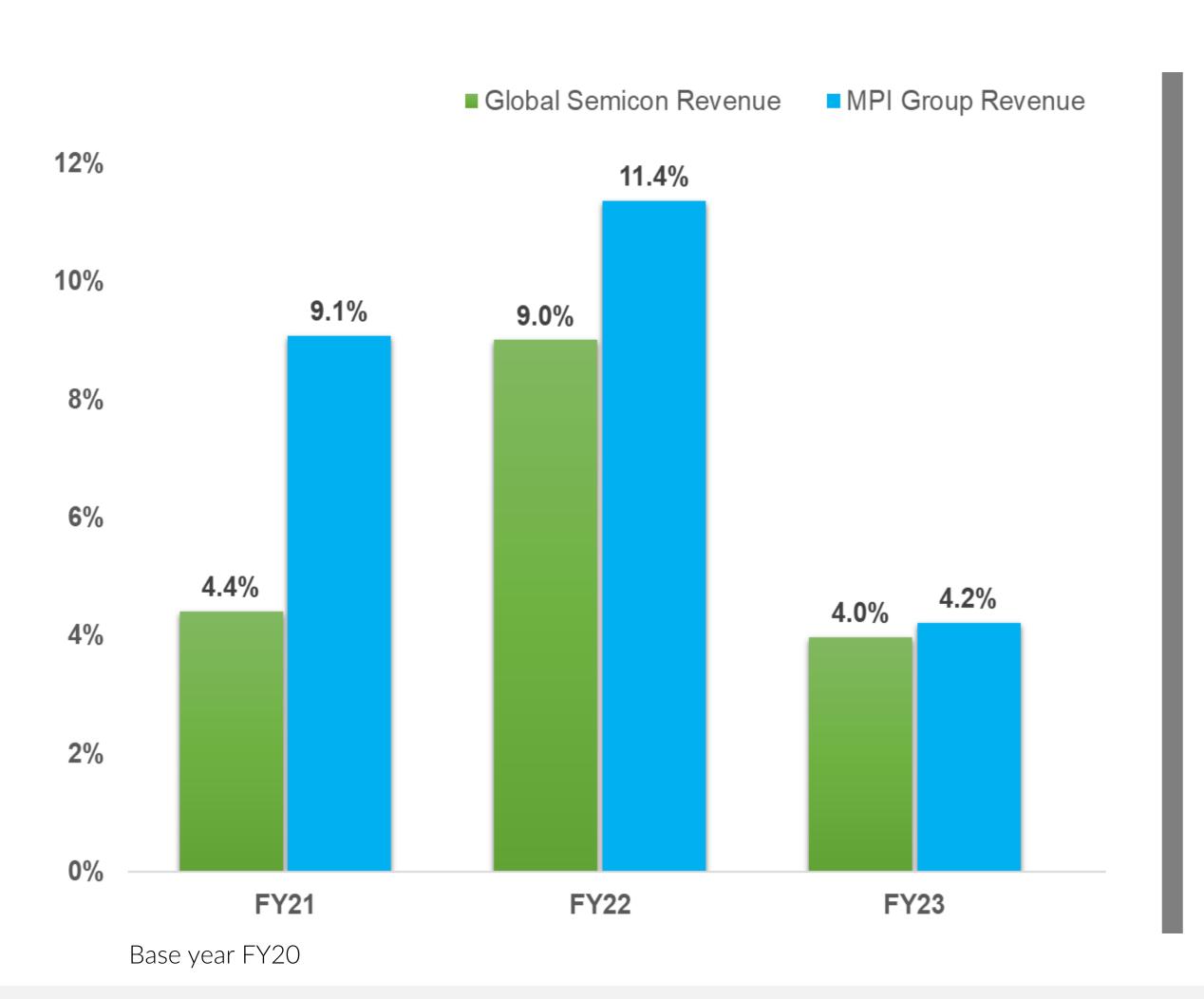


Elevating inventories & dipping chip prices, fueling the decline of semiconductor market

Source: Statista; Canalys



### MPI HAS OUTPACED INDUSTRY GROWTH EVEN IN PREVALENT MARKET ADJUSTMENTS



Right strategy - market segment to play in, competitive pricing

Investments in growth areas

Anchor customers

Strong cash position

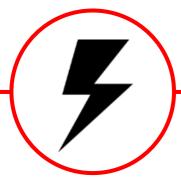


### OTHER CHALLENGES IN SHORT TERM AFFECTING TOPLINE & BOTTOMLINE

# Electricity rates

# Commercial electricity tariff hike

- Upgrading to efficient facility equipment, digital sensors to track electricity consumption and installing solar panels
- Requires substantial investment



# Employee wages & working hours

# Wage increase & 45 hour working week

- Driving plantwide digitalization & floor space consolidation
- Optimizing each resource to increase plant wide productivity



# Increase in machine cost

# Machine & delivery cost up

- Deployed teams to plan in advance & monitor material as well as machine deliveries
- Carsem to avoid shipment by air as much as possible and prefer vessel to save costs



# Steep inflation

# Rise in prices of raw materials

- R&D team is investing time in value engineering to optimize cost
- In some cases, Carsem passes on the cost to the customers depending on the volume of business



# Talent crunch

# Hard to get good semiconductor talent

- Carsem is working with specialized agencies to get good talent from worldwide
- Carsem is also investing in technical learnings for existing employees to upskill





# MPI's response

### COST PRUDENCE MEASURES – IMMEDIATE RESPONSE TO MARKET CONDITIONS

Continuous measures are taken to make a positive impact on costs, make processes efficient and proliferate it to all the sites



Smart Sense to monitor electricity on each machine



Digital transformation and automation initiatives for better OEE



Freight cost reduction by consolidating shipments bi-weekly











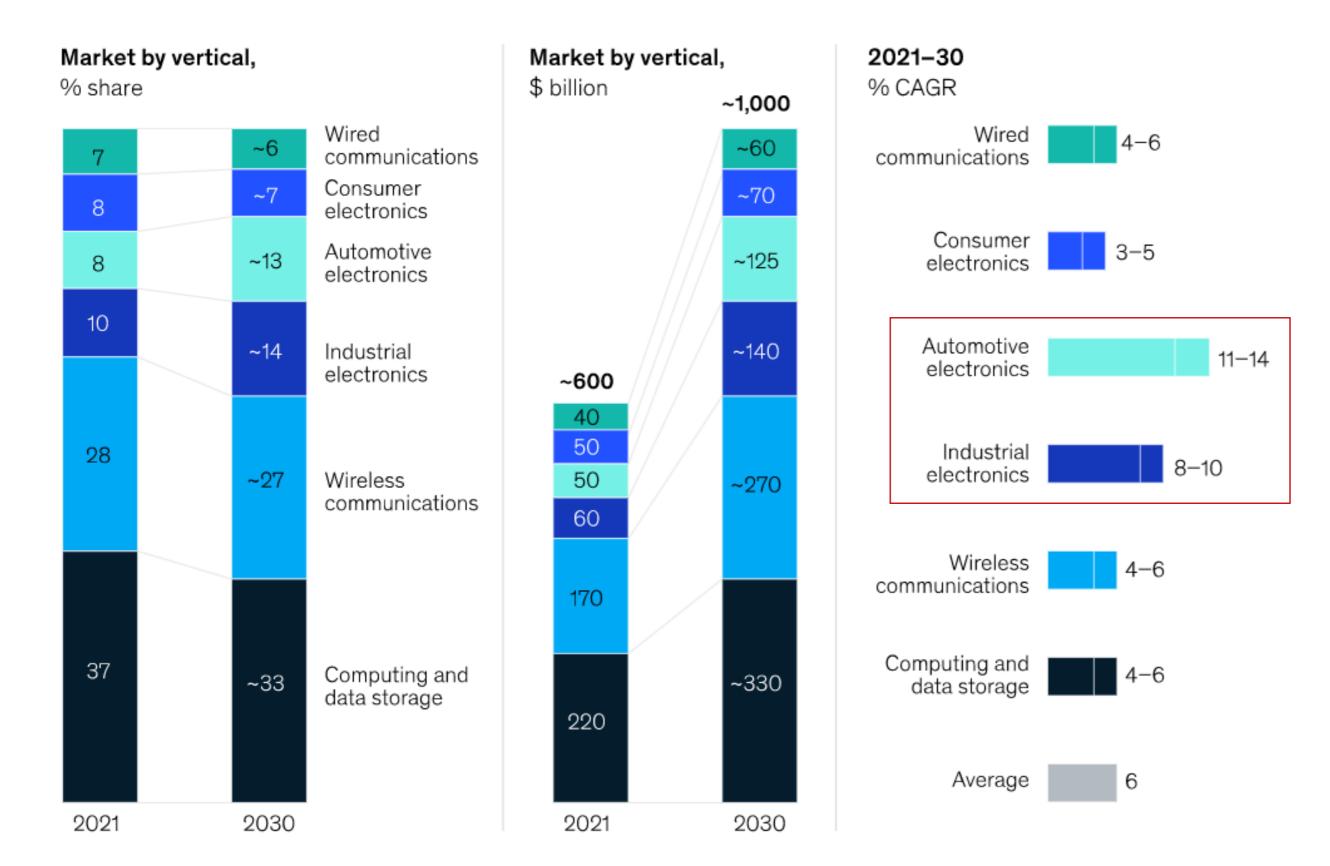


Ongoing discussions with vendors to install solar panels on the rooftop



## LONG TERM SEMICONDUCTOR DEMAND IS SET TO GROW, DRIVEN BY AUTOMOTIVE AND INDUSTRIAL SEGMENTS

### Global semiconductor market, 2021-30



Source: McKinsey

### Significant opportunities ahead

### Electric vehicles

• 30% of global vehicles will be electric by 2030 ( ~ 7X vs. 2021)

### SiC/ GaN technology

- SiC based EVs are expected to grow from 1 mil units in 2021 to ~13 mil units by 2030, driving total auto SiC market expansion
- Significant spending is announced on front-end but not as much on the backend

### 5G connectivity

• Prospects beyond phone – automated factories, AI, smart cities, AI enabled cars, etc.

### Semicon investments

• Substantial public and private spending is announced, globally

### Strong pipeline

• Tech. advancements in automotive and power segments augur well for Carsem's strategy aligned with these segments



# Growth strategy

OUR LONG TERM VISION IS TO BE THE LEADING OSAT FOR AUTOMOTIVE, DRIVEN BY 4 STRATEGY TENETS



# Sales

- Strategic sales across application & geography segments
  - Sharp sales pipeline management



# People

- Strategic workforce restructuring & hiring
  - Upskilling, training
  - Covid mitigation, Employee engagement



# Technology



- Investing in SiC, MEMS sensors, GaN, 5G testing
- Advanced packaging inorganic options for modules/ 3D printing/ design house
- Robust R&D; own product (TVS)



# Quality

- Zero Defects Culture
- Automation, high productivity
- State-of-the-Art Equipments





# Sales – Target segments to play in

MPI MADE A STRATEGIC MOVE TOWARDS UPCOMING TECHNOLOGIES

### Continued investments in complex packaging technologies



SiC adoption in EVs is gaining momentum – Experience of handling SiC packaging will lead the way



Customized sensors used for monitoring several data points – multi-functionality in small, cost-competitive, customized packages



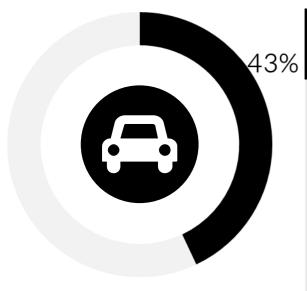
5G technology has a bright future – it is small for Carsem right now but in the next few years it will ramp up





# Sales – Revenue composition

### AUTO REMAINS STRATEGIC - GROWN FROM ~29% IN FY18 TO 43% OF OUR SALES NOW



% Revenue share

# AUTOMOTIVE

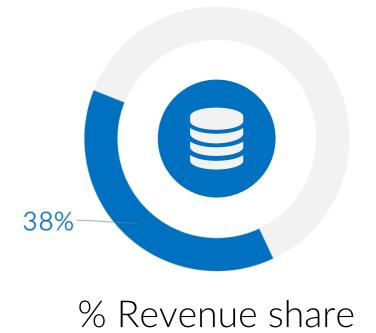
Long term growth is driven by electrification,
 ADAS/ AD, safety, and connectivity trends



% Revenue share

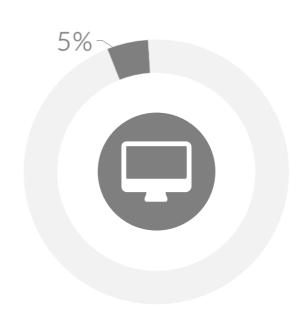
### CONSUMER & COMMUNICATIONS

- 5G and IoT are unlocking multitude of use cases smart cities, healthcare, etc.
- Semiconductor demand is likely to ride this wave with need for advanced packaging solutions



### **INDUSTRIAL**

- With Big Data and Industry4.0 gaining further momentum, need to power data centers & servers is growing
- This high power & high efficiency requirement is fueling new innovations



% Revenue share

### PC/ NOTEBOOK

• Consumer electronics industry sales witnessing significant downward trend as the demand induced from trends such as WFH, online education, etc. normalizes with opening up of offices/ schools across economies

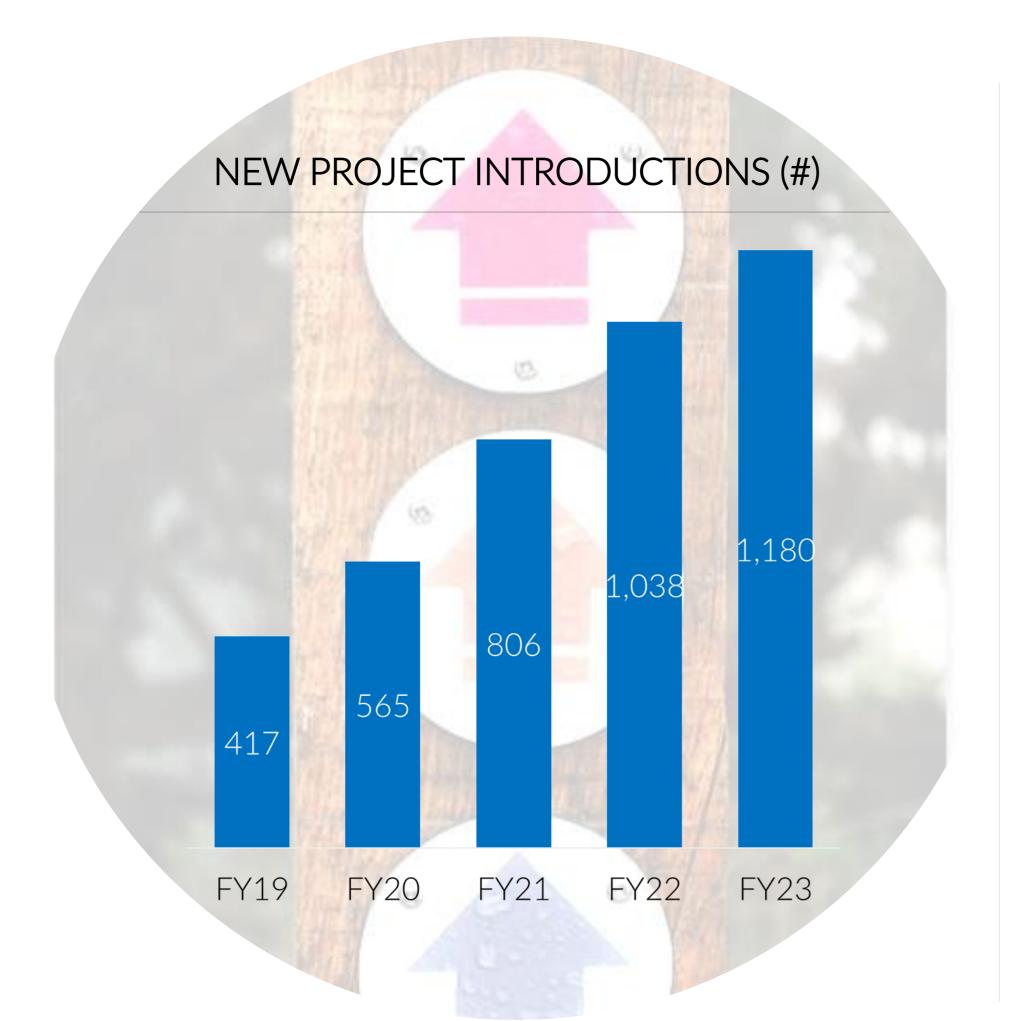
NOTE: Remaining 1% share of revenue is towards Miscellaneous applications





# Sales – Pipeline

#### HEALTHY PIPELINE BUT RECESSIONARY RISKS HAVE PUSHED PROJECTS TO FUTURE QUARTERS



- Carsem has a healthy order book with major projects coming from the Automotive segment
- Pipeline is full but the recent wafer shortage & end customer demand drop/ postponement has pushed projects to future quarters
- Ease of travel has helped Carsem team & customers engage in on-site physical meetings, driving closer collaboration on new pipeline projects in the last 6 months





# Technology – Automotive segment

#### INNOVATING IN LINE WITH STRATEGY TO BE GLOBALLY PREFERRED OSAT PARTNER FOR AUTOMOTIVE

### Major trends impacting semiconductor demand (Mobility disruptions)



### Electrification

Novel battery technologies, growth of electrical powertrain, demand for power electronics



### Autonomy

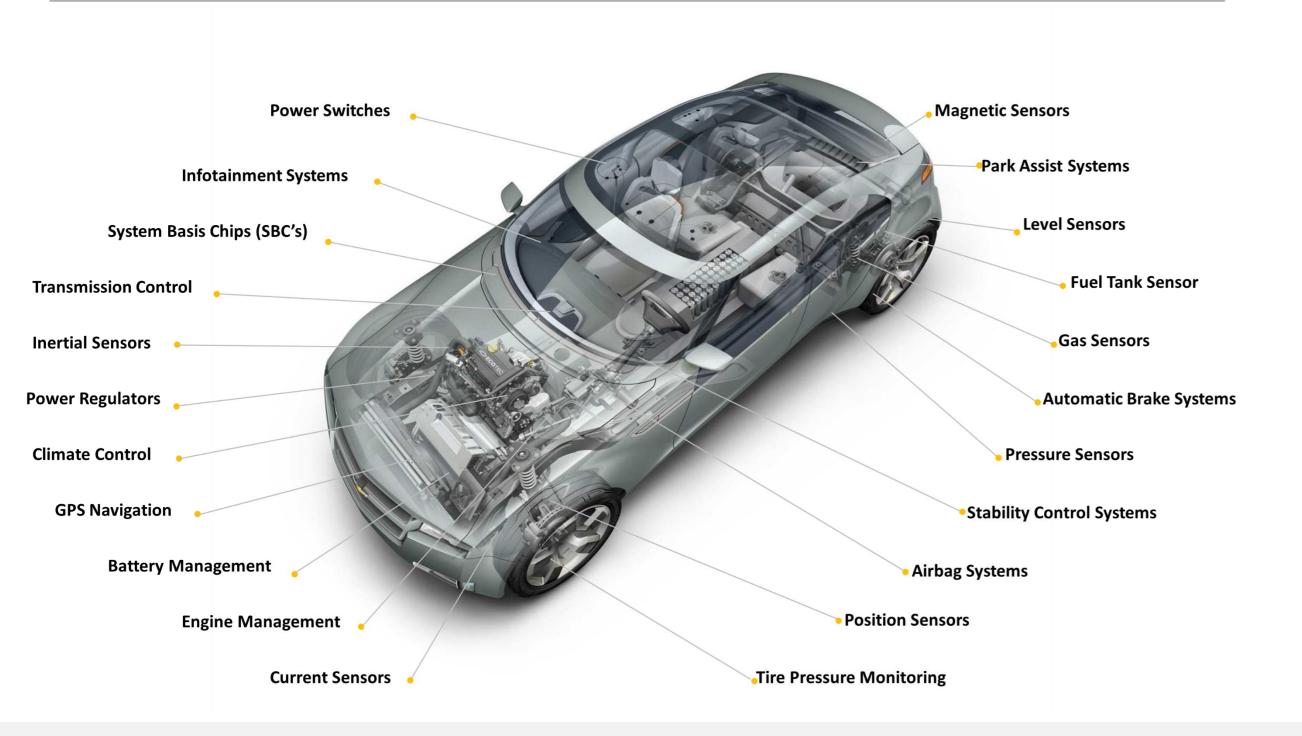
Surge in autonomous driving platforms & advanced safety features



### Connectivity

New use cases (V2X, V2V, OTA) - progression in connectivity technology (5G, WIFI-6)

#### >20 years as a certified automotive supplier



#### Carsem Technology Value Propositions & Activities

#### MEMS & Sensors - riding 'Electrification' and 'Sensorization' wave

- ✓ SiP Pressure sensors for ICE and Safety are ramping up for Automotive, Gas & Flow sensors – safe launch production stage
- ✓ Expanding in temperature/ humidity sensor applications with qual, in parallel with ramp up phase production tooling NRE on going with tool fabrication
- ✓ New focused development: current sensor for EV with wettable flank technology sample launched for qualification
- ✓ New design concept under review for Lidar / Radar segment

#### Power Packaging

- ✓ MIS solution Automotive PMIC Module, pass qualification, under safe launch
- ✓ Module development with SiC for automotive

#### RF for Connectivity

✓ Differentiated support on diverse applications using Gallium Nitride (GaN) technology





### Technology – Industrial segment

#### EXPANDING PORTFOLIO ALIGNED WITH TRENDS IN ADVANCED PACKAGING & TESTING FOR POWER

### Major trends impacting semiconductor demand



### Industry 4.0

Higher performing devices with greater functionality driving models that enable increased flexibility, higher productivity & lower costs

#### >30 years in power packaging





### Big Data

More servers with high power & high efficiency to support large volumes of data

#### Carsem Technology Value Propositions & Activities

#### Power Packaging

- ✓ Awarded the next generation of Power stage products for servers and workstation (Cu Clip). In qualification will be ready for HVM in Q3 FY23
- ✓ Development on chip embedding package, expected HVM in FY22/23
- ✓ Development of Cu Clip for automotive in progress, expected HVM in Q3FY24
- ✓ Setup Taiko Ring Removal process for ultrathin die application, in production
- ✓ High power (2KV/100A) Test solution under development, with applications in base station/industry power supply/big data center

#### MEMS & Sensors

- ✓ Ramping gas sensing applications & flow sensor under R&D, target production in Q4 FY23; also, ramping current sensor and magnetic sensor applications. Expanding further in high end applications with special coating on die technology under devp.
- ✓ Hermetical & Non hermetical Ceramic Packages (Gyroscopes & Accelerometers) with safe launch. Targeted production by Q2 FY24





# Technology - Consumer/ communications segment

#### TAPPING INTO THE 5G REVOLUTION THROUGH ROBUST CUSTOM OFFERINGS

### Major trends impacting semiconductor demand



5G

High data rates, massive connectivity and ultra-low latency, catalyzing remote health care, autonomous driving, AR/ VR experiences

#### IoT

Need for combining functionalities – security, connectivity & microprocessors - stimulating usage of sensors, actuators & computing power

#### Carsem in Communication



#### Carsem Technology Value Propositions & Activities

#### RF (5G mobile, WiFi6)

- ✓ FC MIS with underfill plus exposed die process start HVM in Q4FY23
- ✓ QFN SIP solution : FC+ SMT, power management application under development, high end wireless charging, fast charging , Li-Ion battery management

#### Power Packaging

- ✓ RF Power (mid-high) packaging expertise for handphones/ 5G base stations; high volume manufacturing experience of handling GaN
- ✓ RF module/ high power switch for 5G base stations remains focus

#### MEMS & Sensors

- ✓ Optical sensor using clear compound under volume production (for VR, wearables, etc.); and IMU for hand held devices with qualification lot shipped
- ✓ Expanding into high grade BOM for RF segment and qual in progress





### Technology-Immediate focus

SiC - UNLOCKING RF & POWER APPLICATIONS

### CARSEM ADVANTAGE

- ✓ Already working with the No.1 SiC wafer supplier in the world
- ✓ Optimized packaging & performance for better results
- ✓ Ongoing advanced SiC packaging solutions for major customers in Europe and China
- ✓ Dedicated SiC technology trained team for assembly & test
- ✓ Enhanced dedicated floor space & lines to cater to latest technology SiC & GaN
- ✓ Witnessing double digit growth YoY with strong pipeline for the coming years in SiC

SiC technology for power has a promising future, globally

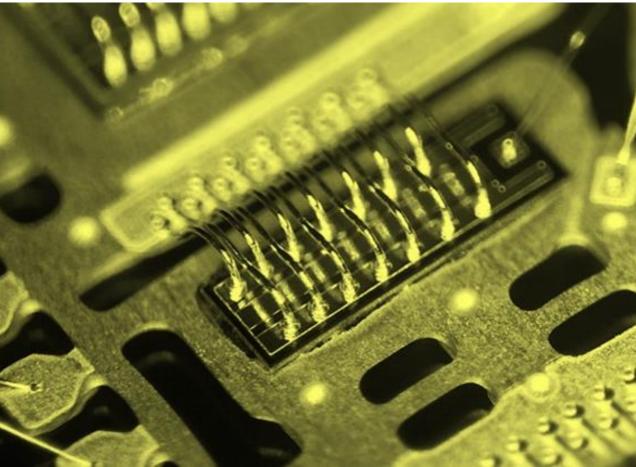
Carsem S-site at Ipoh, Malaysia is already working with major players on pipeline for SiC packages





Benefits of SiC over previous gen materials

- ✓ Wider bandgap,
- ✓improved energy conversion efficiency & power density,
- ✓ higher thermal conductivity (3-4X Si/GaAs/GaN),
- ✓ higher switching frequencies, and reduced system size





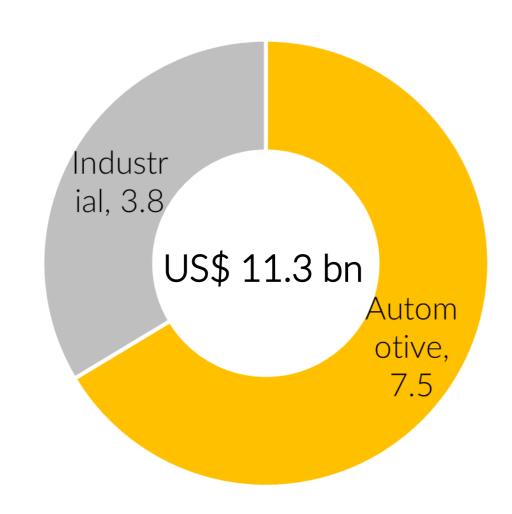


# Technology-Immediate focus

#### GROWING DEMAND FOR SILICON CARBIDE TECHNOLOGY

The silicon carbide device market is accelerating at breakneck speed, driven by automotive

Power SiC devices market, 2030e US\$ billion

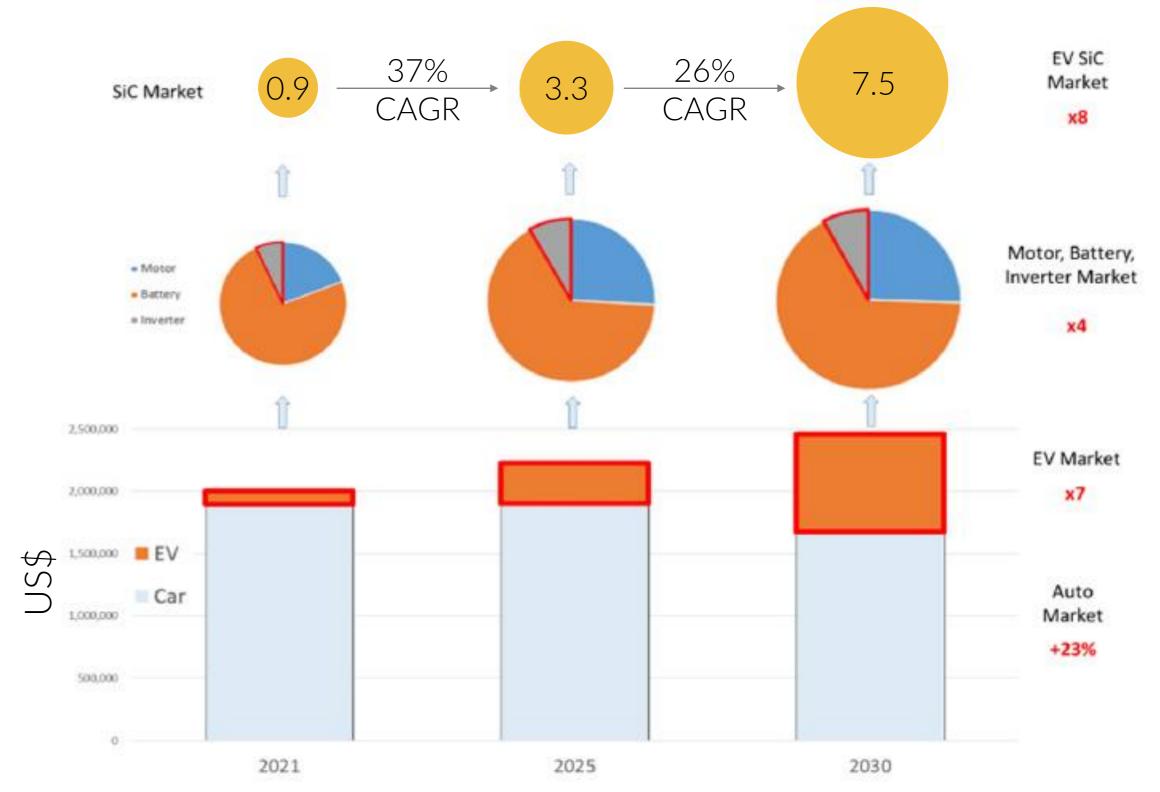


from slightly over US\$ 1 billion market in 2021...CAGR ~ 30%



Auto-related (EV) SiC market growth to stand out, rising to US\$3.3bn in 2025 and to US\$7.5bn in 2030

from ~ US\$0.9bn in 2021



The numbers on the right show the growth of each market compared with 2021

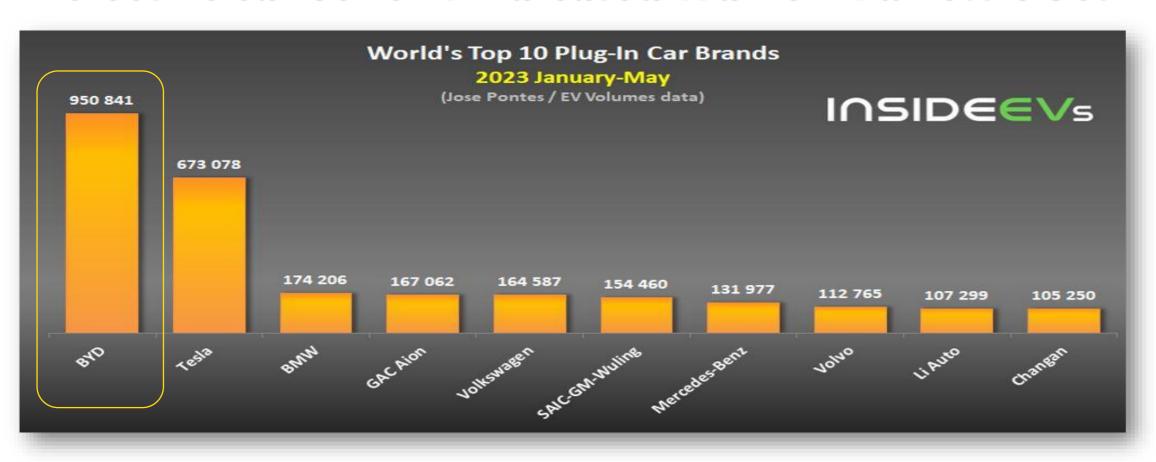




### Technology-Immediate focus

STRATEGIC FOCUS ON AUTOMOTIVE SEGMENT GROWTH IN CHINA

Chinese brand is No.1 in EV Sales in 2022 & 2023 YTD BYD beats Tesla in 2022 EV sales, as the world's No 1 electric car seller vindicated Warren Buffett's bet



- Strong EV sales in China
- 83 automotive projects are already in different stages of pipeline
- Transfer some technology & experience manpower from Ipoh, Malaysia



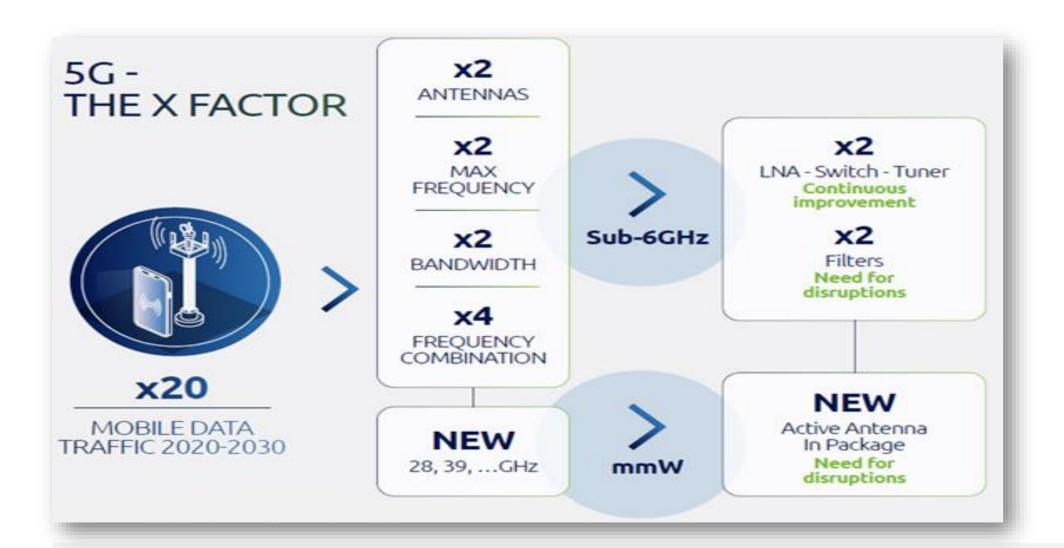


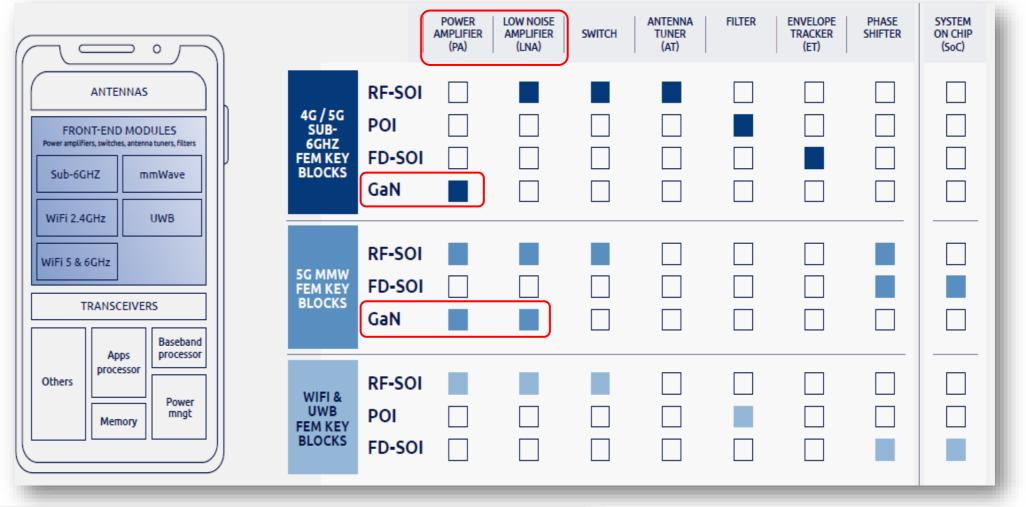




# Technology – Immediate focus

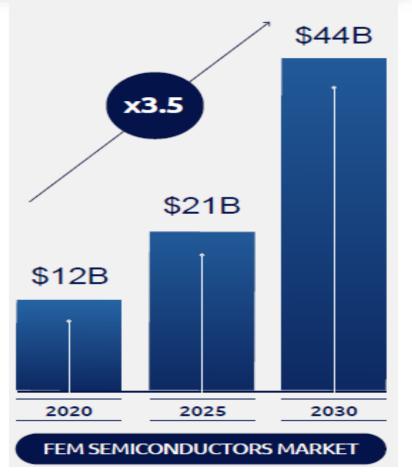
Gan for radio frequency (RF) Applications – 5G base stations





#### Significant growth is projected for front end modules (FEM) in the next 8 years

- ✓ Carsem spent US\$ 12Mil for 5G RF FEM. Carsem Suzhou already has experience in FEM for 4G/5G, include DiFEM Module/DiFEM Module/Duplexer+ Quadruplext and Inregular SiP package, expected initial production in Q2FY24
- ✓ Industry technology trend suggests that the business of GaN related FEM will be much more than
   4G
- ✓ Carsem Suzhou is already engaging with main 5G players of China for 5G base stations FEM



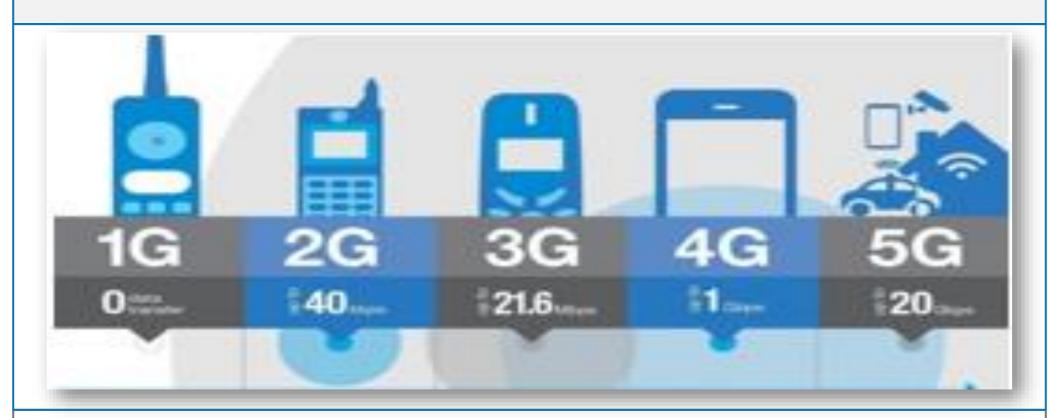
Source: Yole, Ericsson, Soltec, Qualcomm





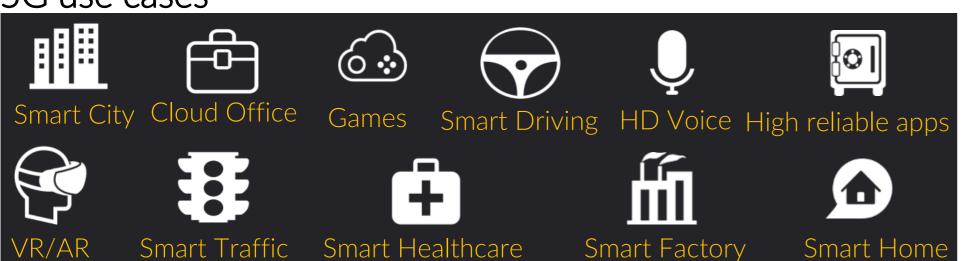
# Technology – Future focus

#### 5G - Next Generation of mobile broadband



- ✓ Exponentially faster download & upload speed
- ✓ Drastically decreased latency
- ✓ Implementation of IOT, Autonomous Cars, Artificial intelligence.
- ✓ High frequency signals on shorter wavelengths will require more base stations than usual 4G

#### 5G use cases



#### **5G TESTING**

### Carsem Suzhou has been working extensively on 5G test technology development

- ✓ CSZ is working with 10+ customers for 5G device testing
- ✓ Completed 5G and Wifi7 RF test capability development, up to WiFi7 7.125GHz
- ✓ Continuing engagement with specialized customer for 5G FR2 (mmWave) testing development
- ✓ Building an exclusive 5G RF domain specific test development team to be the best in this field

#### CSZ R&D capability - able to support 5G sub 6GZ, but not ready for 5G mmWave yet

	<b>2</b> <del>ê</del>	36	4 Gue	<b>5</b> 6	56° EE	
Bandwidth Product	800MHz~2GHz	2GHz~2.2GHz	1.7G~2.7G	3.3GHz~6.0GHz (Sub- 6GHz)	>28GHz (mmWave)	
Froduct	6MHz~24MHz	15MHz	15MHz~130MHz	<1G Hz	>1G Hz	
Switch	✓	✓	<b>✓</b>	<b>✓</b>		
Filter (SAW/BAW)	✓	✓	✓	✓		
Diplexer/Multiplexer	✓	✓	✓	✓		
PA (Power Amplifier)	✓	✓	✓	✓		
LNA (Low Noise Amplifier)	✓	✓	✓	✓		
Antenna Tuner	✓	✓	✓	✓		
SiP (include 2 or more components into a package)	✓	<b>✓</b>	<b>✓</b>	<b>✓</b>		





# Technology – Future focus

#### MODULES

#### Entirely new SMT Line



3D X - Ray



C - Mold



#### CARSEM SUZHOU

- ✓ Invested in dedicated machines for FEM module line under production
- ✓ Invest in dedicated machine and skilled manpower to extend FEM line capacity
- ✓ Attacking high end customer FEM product, under engineering stage

#### CARSEM MALAYSIA

- ✓ Assembling advanced packages with complete flexibility for customization
- ✓ Major portfolio of advanced packages is with big semiconductor companies in NA & EU
- ✓ Investing in superior machines and skilled manpower to handle advanced packaging

#### BENEFITS OVER STANDARD PACKAGES

RELIABILITY **COST SAVING** PERFORMANCE

ROBUST REDUCED SIZE

**CUSTOMIZABLE** 







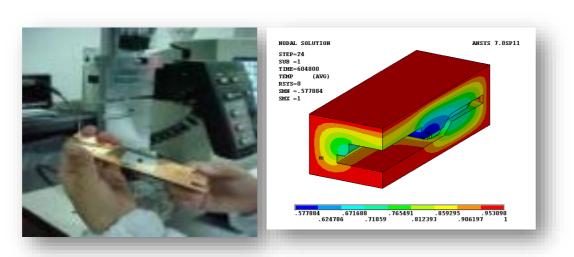
## Technology - Carsem technology center

DEDICATED TECHNOLOGY CENTER TO DRIVE INNOVATION & TECHNOLOGY DEVELOPMENT

CARSEM TECHNOLOGY CENTER (CTC) – 4M APPROACH TO R&D

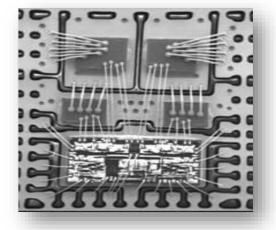
#### **MATERIAL**

- Materials lab,
- Design & Simulation



#### **METHODOLOGY**

- Process development
- Total 75 active patents



#### **MACHINE**



Dedicated to package/process/materials development

#### MAN (HUMAN CAPITAL/ EXPERTISE)

 Total headcount: 66 (Technical Management ~8%, Project Management ~34%, Engineering ~58%)







# Quality & productivity focus

INVESTING IN AUTOMATION & INDUSTRY4.0 TO ACHIEVE ZERO DEFECTS & HIGH PRODUCTIVITY GOALS

### End Game – Smart factory



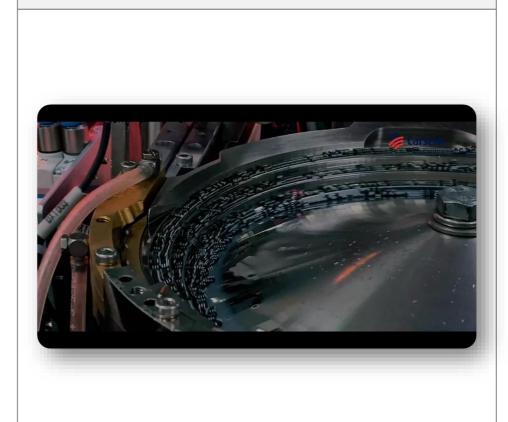
#### Highlights

Highly automated line with minimal dependence on people

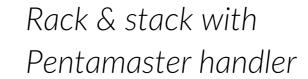
> Productivity improvement

Connecting shop floor & processes

### State of the art advanced facilities, towards lean manufacturing



5G testing











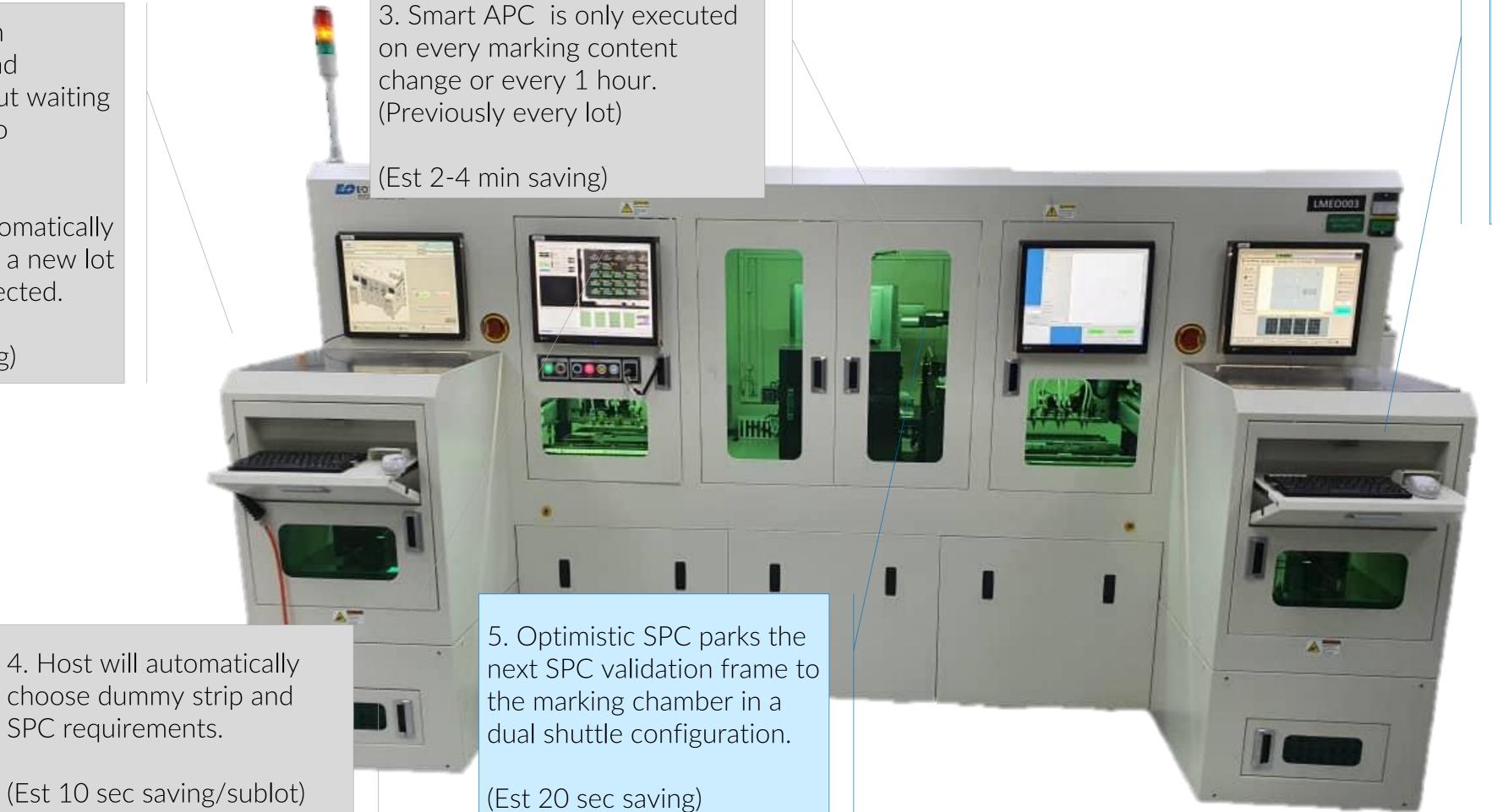
# Quality & productivity focus

AUTOMATION: EO Laser Continuous Run Enhancement

1. Operator can continuously load magazine without waiting for current lot to complete.

2. New lot is automatically tracked in when a new lot magazine is detected.

(Est 1 min saving)



6. After machine validates all frames is complete, magazine change is done and lot is tracked out.

(Est 1 min saving)

### Improvement:

UPH increase by

19%

#### Legend:

Changes on machine

Changes on host





# Quality & productivity focus

#### CERTIFIED ON INDUSTRY'S LEADING PERFORMANCE PARAMETERS

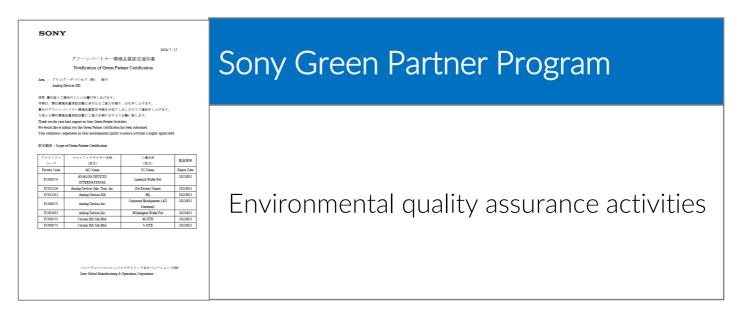


















# Awards and recognitions

QUALITY & PEOPLE

#### BEST SUPPLIER AWARDS received















Best supplier award, 2022

HEK, China

Best Partner Award, 2022

PSE, China

Best supplier award, 2022

QST, China

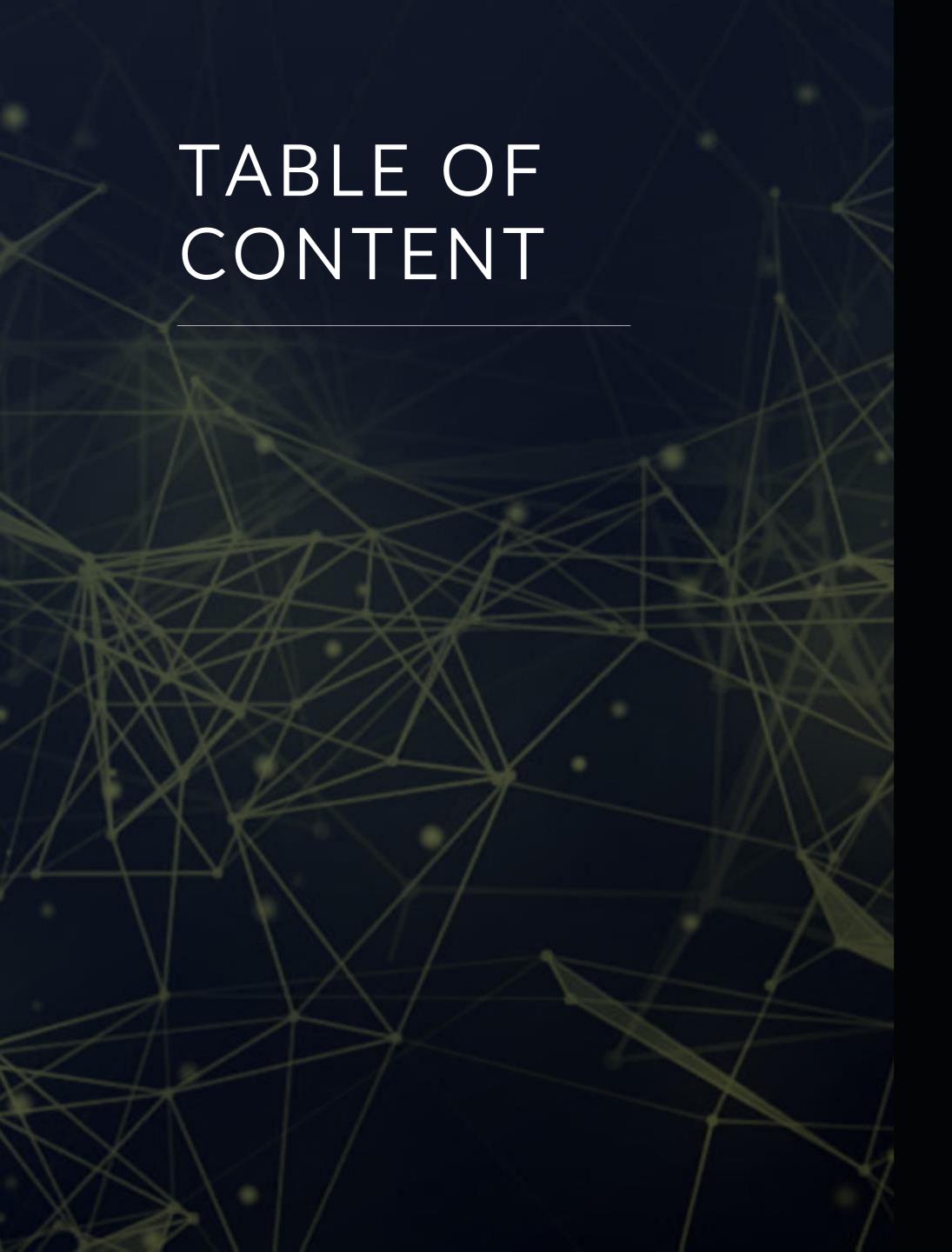
Best quality service award, 2022

EPM, China

Best supplier award, 2022

Awards to assembly and test engineering team, 2022

Kangxi, China



INTRODUCTION CORPORATE OVERVIEW BUSINESS OVERVIEW SUSTAINABILITY GROWTH DRIVERS FINANCIALS & SUMMARY



# Financial highlights

Q4 FY23 SNAPSHOT

REVENUE	With the challenges faced in China & worldwide consumer demand drop, MPI closed Q4 FY23 at US\$ 107M
EPS	Despite all the challenges & high costs, MPI Q4 EPS witnessed a positive swing of ~ 13 Sen
CAPEX	Good or bad times, Carsem invests in replacing old machines & getting new technology in. Q4 FY23 – RM 59M
CASH	Even in these uncertain market dynamics – MPI cash increased in Q4 by 4% YoY to RM 801M
CHALLENGES	Geopolitical stress, global end market demand drop, Rise in costs & Manpower constraints
SEGMENTS	Automotive segment is strengthening; Automotive (43%); Industrial (38%); Consumer (13%)



# Key financials

MPI GROUP RESULTS AT A GLANCE

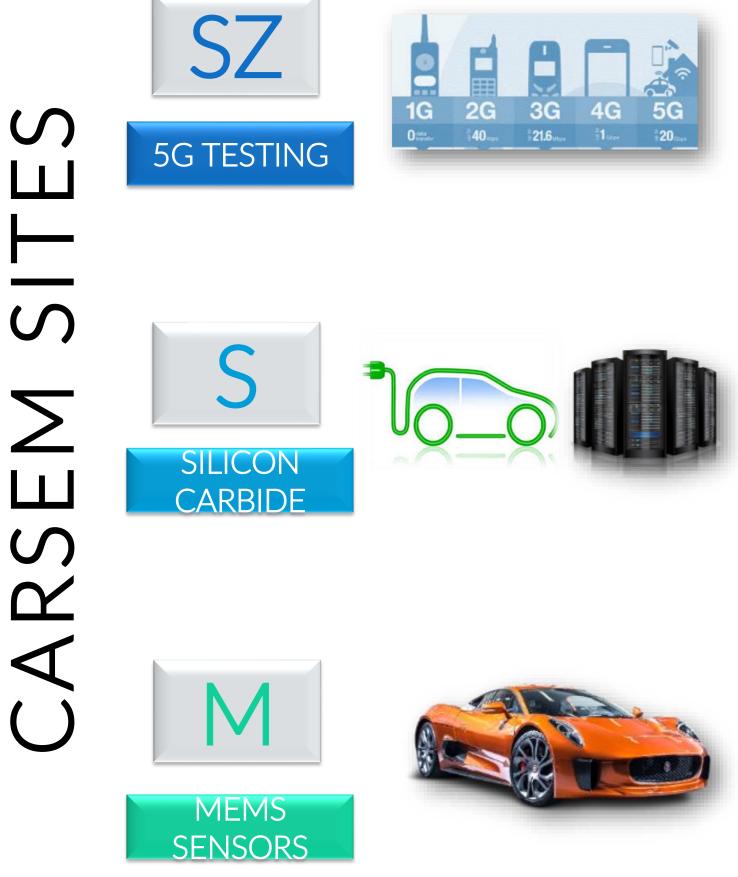
	Q4 FY23	Q3 FY23	Q4 FY22	Q4 vs Q3	Q4 vs Q4	YTD FY23	YTD FY22	YoY
	RM mil	RM mil	RM mil	%	%	RM mil	RM mil	%
Revenue	482.4	471.9	612.0	2%	-21%	2,044.7	2,416.1	-15%
(LAT)/PAT	17.1	(8.4)	93.0	>100%	>-82%	108.1	384.9	-72%
PATAMI	8.1	(17.8)	80.5	>100%	>-90%	61.3	328.9	-81%
EPS (sen)	4.09	(8.97)	40.47	>100%	>-90%	30.84	165.62	-81%
EBITDA %	21%	17%	30%			23%	31%	
Capex	58.9	44.3	93.9	33%	-37%	251.7	729.7	-66%
Dividend	50	0	50			70	70	
Net Cash	801.4	812.9	771.6			801.4	771.6	
EDR	100:0	100:0	100:0			100:0	100:0	
ROSF	0.4%	-0.9%	4.7%			3.1%	19.4%	

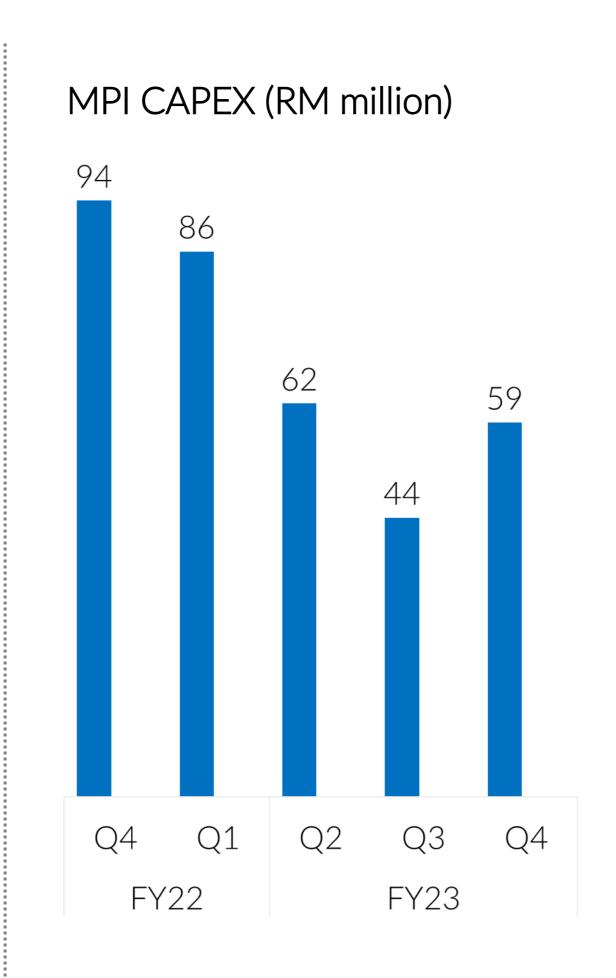


### 湯

### Investments

CONTINUING STRATEGIC INVESTMENTS FOCUSING ON SENSORS, 5G TESTING & SIC/ GaN TECHNOLOGIES





- Hire domain specific relevant people across the globe to support business operations & sales
- Investing in research & development to deliver latest technology solutions to our customers
- Floor space expansion to meet increasing business demands from existing & new customers
- Continuing Industry 4.0 via automation in each factory to have zero defects quality
- **Upskilling** existing operational & technical manpower to be able to perform better with latest technology
- Looking for more anchor customers to secure more guaranteed business in future



### Cash

#### STRONG NET CASH POSITION MEANS STABILITY IN UNCERTAIN TIMES

#### NET CASH (RM million) position remained healthy



MPI is cash rich despite significant capital expenditure and expenses towards managing externalities



### Statement of Profit or Loss

	Q4FY23 RM '000	Q4FY22 RM '000	Changes %
Revenue	482,426	612,035	-21%
Cost of sales	(443,389)	(490,371)	-10%
Gross profit	39,037	121,664	-68%
Operating expenses	(35,235)	(29,189)	21%
Other operating (expenses)/income	7,064	7,926	-11%
(Loss)/Profit from operation	10,866	100,401	-89%
Interest income	8,516	3,380	152%
Interest expenses	(2,732)	(2,361)	16%
(Loss)/Profit before taxation	16,650	101,420	-84%
Taxation	453	(8,373)	-105%
Loss)/Profit for the period	17,103	93,047	-82%
(Loss)/Profit attributable to:			
Owners of the Company	8,137	80,488	-90%
Non-controlling interests	8,966	12,559	-29%
Loss)/Profit for the period	17,103	93,047	-82%
(Loss)/Earnings per ordinary share (sen)			
Basic	4.09	40.47	-90%
Ratio			
GP %	8%	20%	
(LBT)/PBT %	3%	17%	
(LAT)/PAT %	4%	15%	
EBITDA%	21%	30%	



### Statement of Financial Position

	30/06/2023	30/06/2022
	RM'000	RM'000
Non-current assets		
Property, plant and equipment	1,416,233	1,511,323
Right-of-use assets	47,298	52,285
Investment properties	27,026	27,897
Investments	46	46
	1,490,603	1,591,551
Current Assets		
Inventories	149,537	206,279
Trade and other receivables, including derivatives	318,871	356,139
Tax recoverable	4	62
Cash and cash equivalents	1,053,096	964,826
	1,521,508	1,527,306
TOTAL ASSETS	3,012,111	3,118,857



### Statement of Financial Position

	30/06/2023	30/06/2022	
	RM'000	RM'000	
Equity			
Share Capital	352,373	352,373	
Reserves	1,826,261	1,811,656	
Treasury shares	(163,816)	(163,816)	
	2,014,818	2,000,213	
Non-controlling interests	345,570	321,568	
	2,360,388	2,321,781	
Non-current liabilities			
Borrowings (unsecured)	79,480	180,100	
Lease liabilities	21,788	23,566	
Deferred tax liabilities	6,936	2,269	
	108,204	205,935	
Current liabilities			
Trade and other payables, including derivatives	346,104	543,813	
Borrowings (unsecured)	172,184	13,170	
Lease liabilities	3,177	2,781	
Current tax liabilities	22,054	31,377	
	543,519	591,141	
TOTAL LIABILITIES	651,723	797,076	
TOTAL EQUITY AND LIABILITIES	3,012,111	3,118,857	
Net Assets per share attributable to			
owners of the Company (RM)	10.13	10.06	
Net Cash	801,432	771,556	
EDR	100:0	100:0	



# Summary



MPI closes at US\$ 107M, despite several global challenges and demand drop across market segments



MPI has a healthy order book for future quarters even in an uncertain market environment



Carsem continues to invest in SiC & GaN Technology, 5G Testing, MEMS Sensors to grab the next wave of opportunities



Investing in expansion - new factory in Ipoh, additional floor in Carsem S – Site (Ipoh) & a new site in China



Net Cash (RM 801M for investment & M&A), No debts



